

Tunable Metamaterials with Graphene

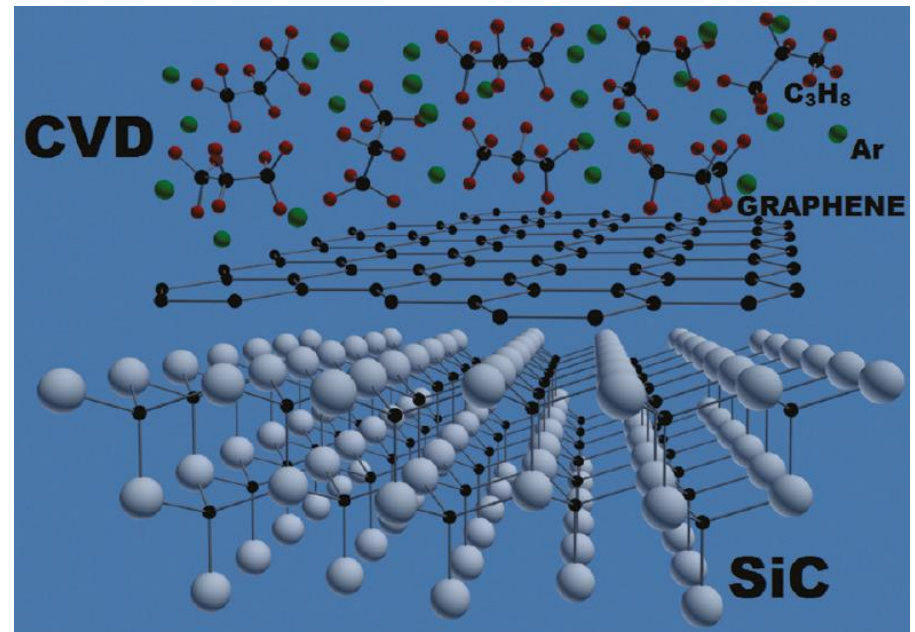
Semih Cakmakyapan, Francesco Pierini,
Levent Sahin and Ekmel Ozbay

Outline

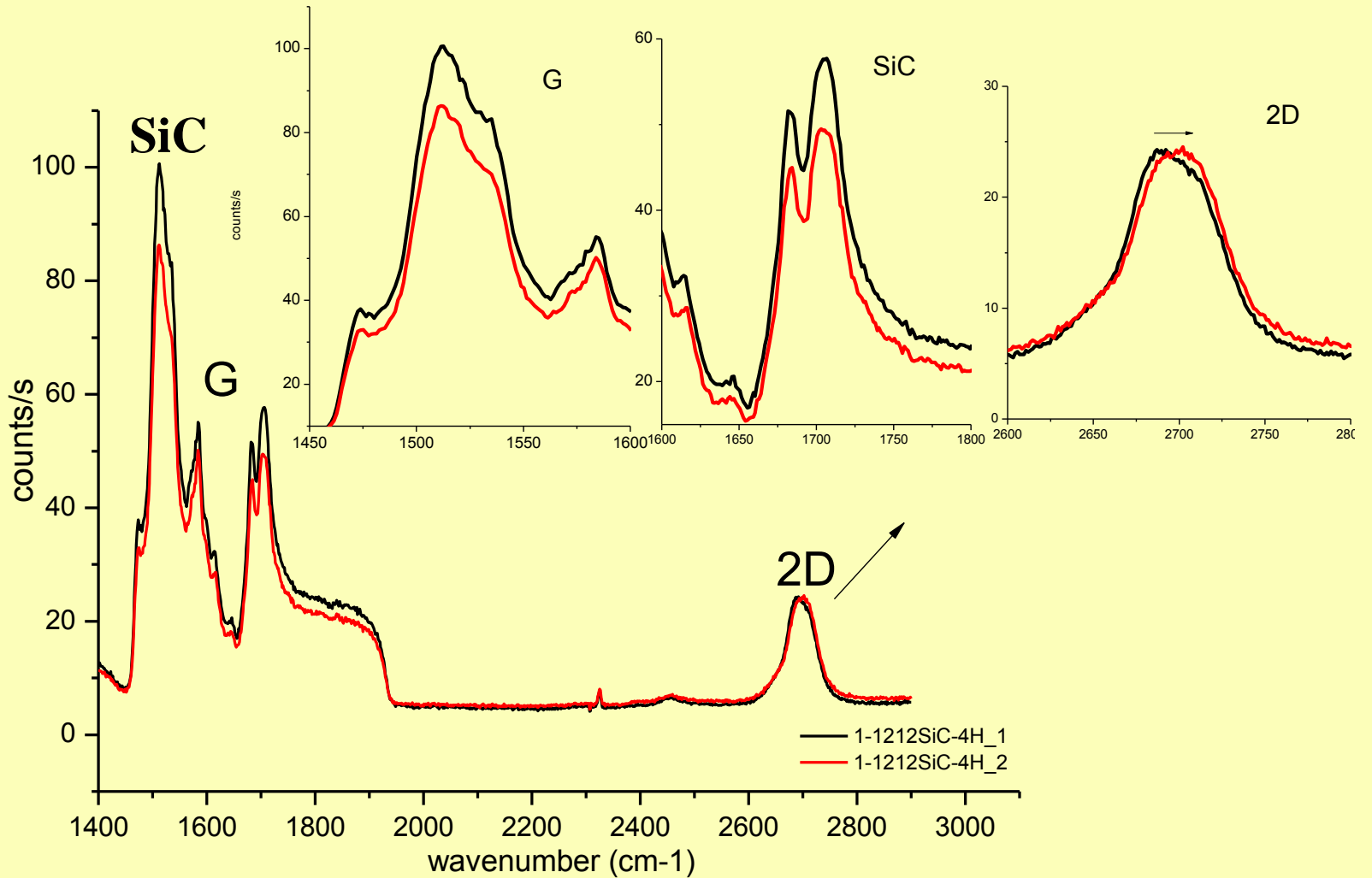
- **Properties of our graphene samples**
- **Overview of the past graphene studies**
- **Graphene plasmonics**
- **Fabrication details**
- **Experimental and Simulation Results**
- **Conclusion**

Epitaxial Graphene on SiC

- Produced by sublimating Si from SiC heated up to high temperatures (round 1600°C)
- Enables processing on single 2", 3" and 4" wafers
- Homogenous, highly uniform deposition

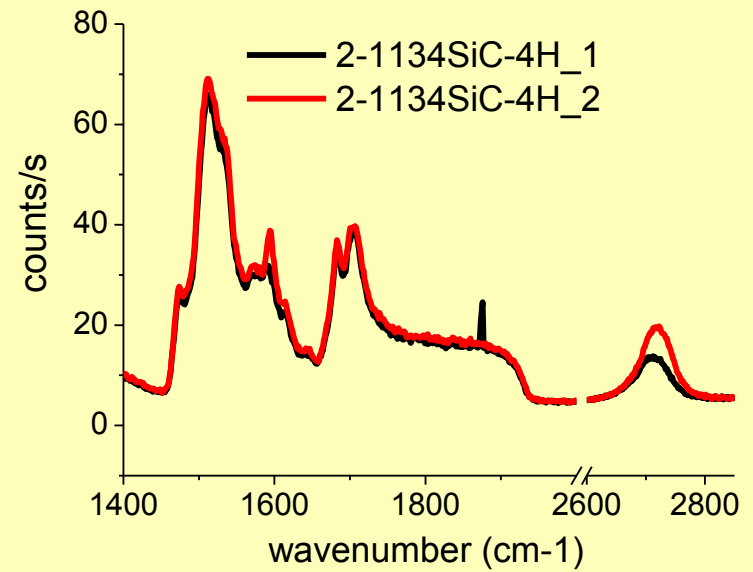
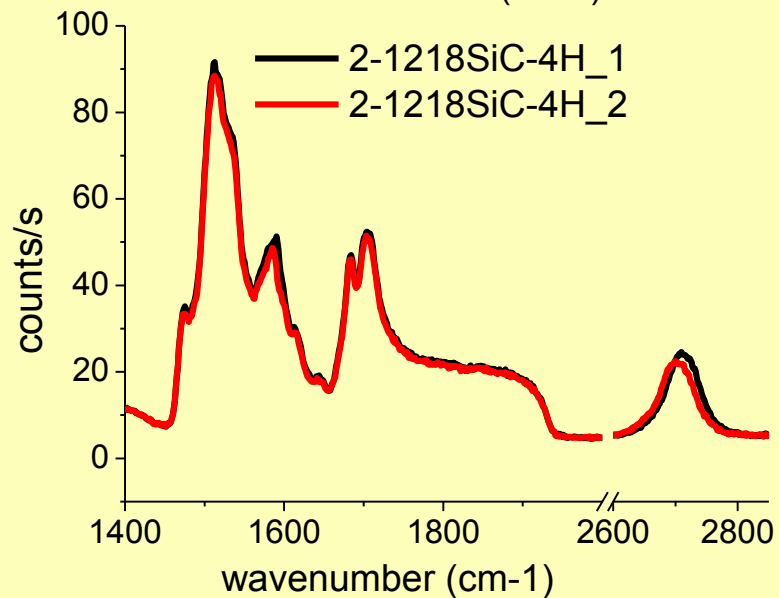
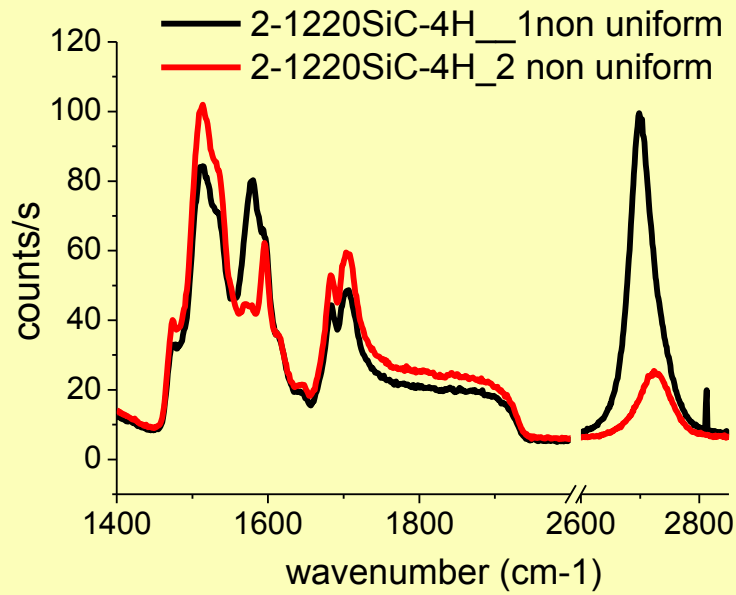


Raman measurements from different regions of the sample

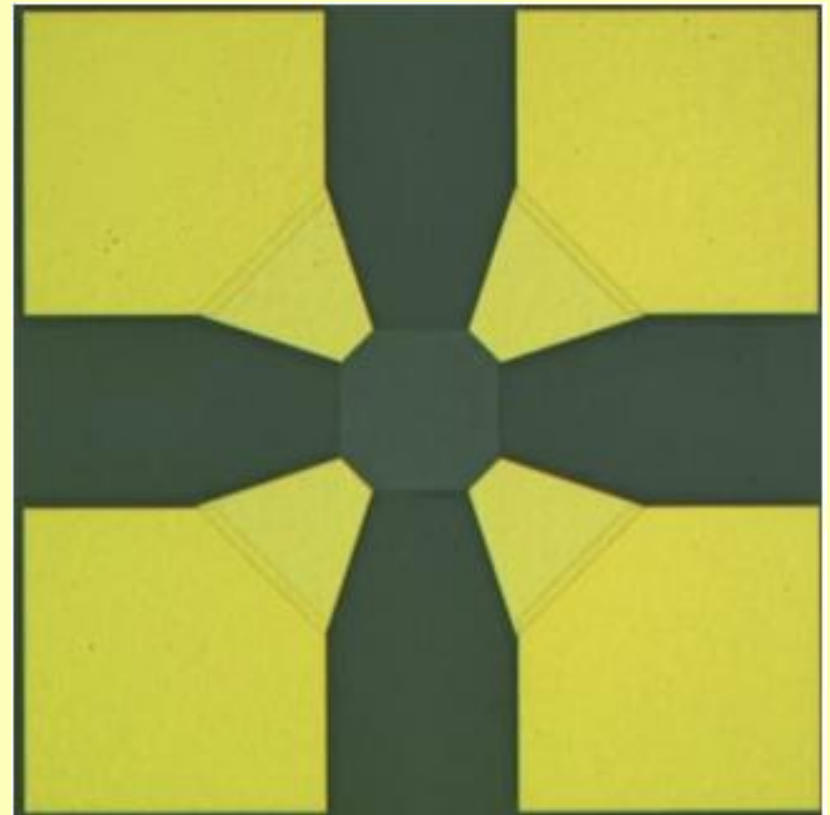
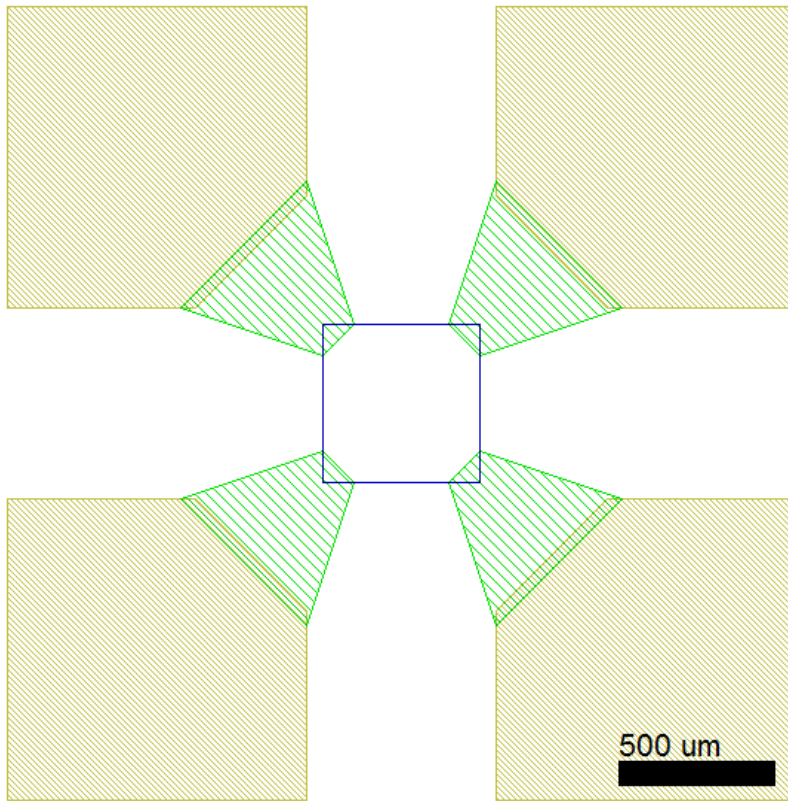


2D and G peaks shift, but there is no shift in SiC peak.

Raman measurements

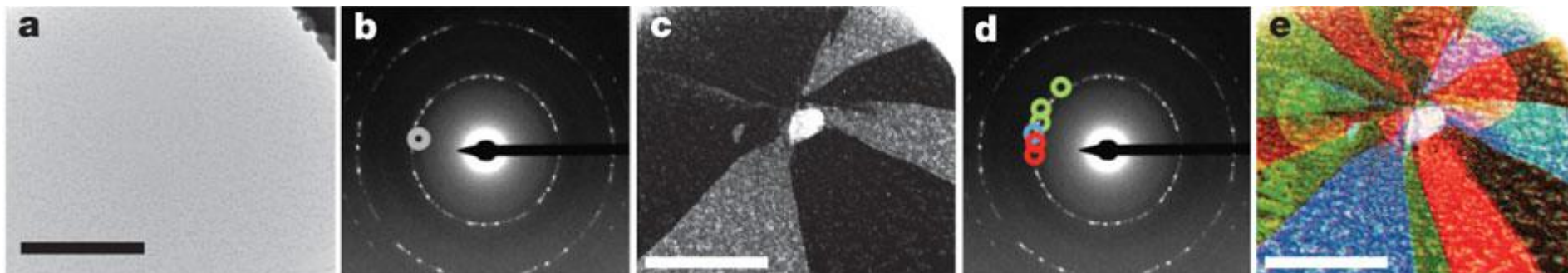


Van der Pauw Devices for Hall Measurements



Hall Measurement Results at Room Temperature

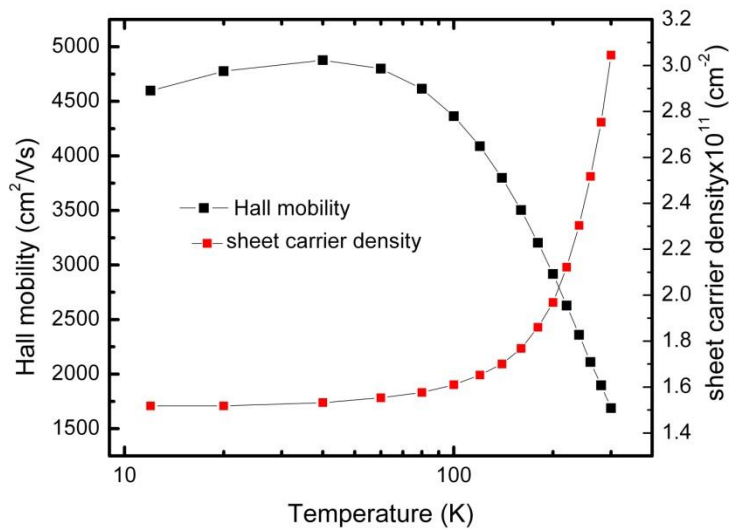
Sample Name	Growth Conditions	Device Number	μ	n	Probe current
			(cm^2/Vs)	(10^{12} cm^{-2})	(μA)
AaEk	1600°C	1	812,0	-1,7	100
		2	882,0	-1,5	500
		average	847,0	-1,6	
AbEk	1600°C + H ₂	1	456,0	-6,3	100
		2	541,0	-3,6	100
		average	498,5	-5,0	
BaEk	1500°C	1	1580,0	23,0	1000
		2	1026,0	30,5	1000
		average	1303,0	26,8	
BbEk	1500°C + H ₂	1	873,0	-1,5	500
		2	1350,0	-0,7	500
		average	1111,5	-1,1	



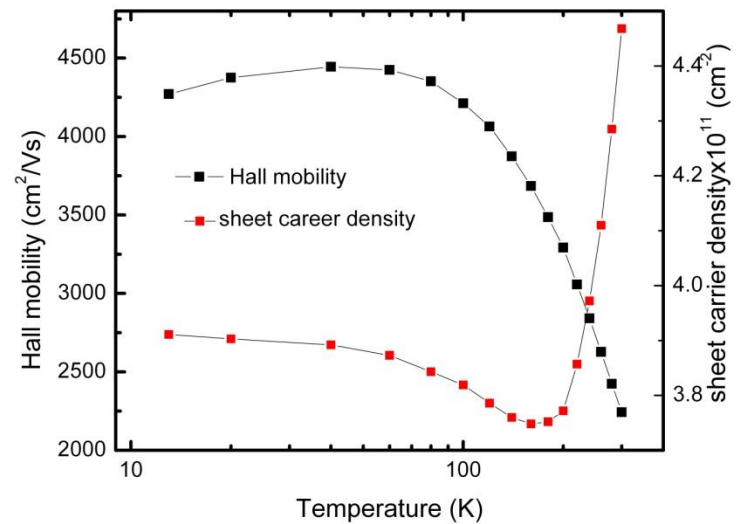
Huang et al. Nature **469**, (2011).

Linköping Samples Temperature dependent Mobility and Sheet Concentration

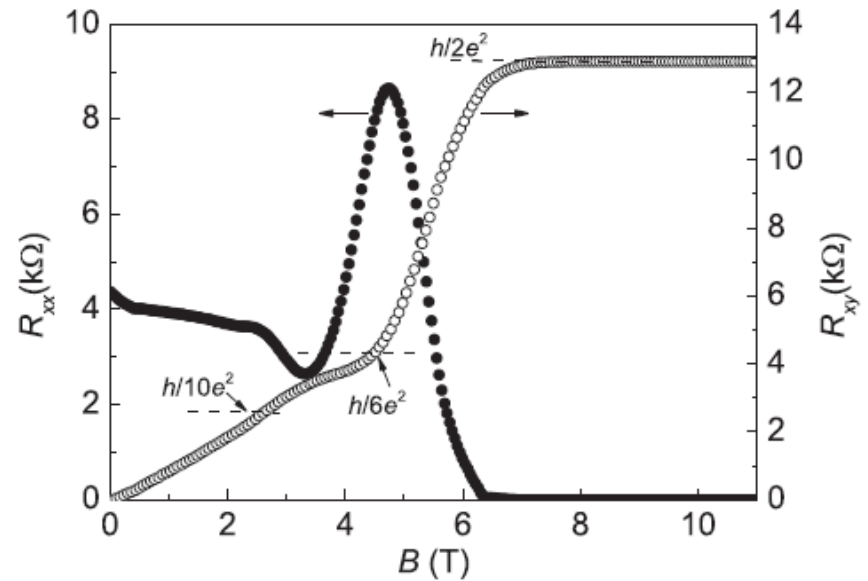
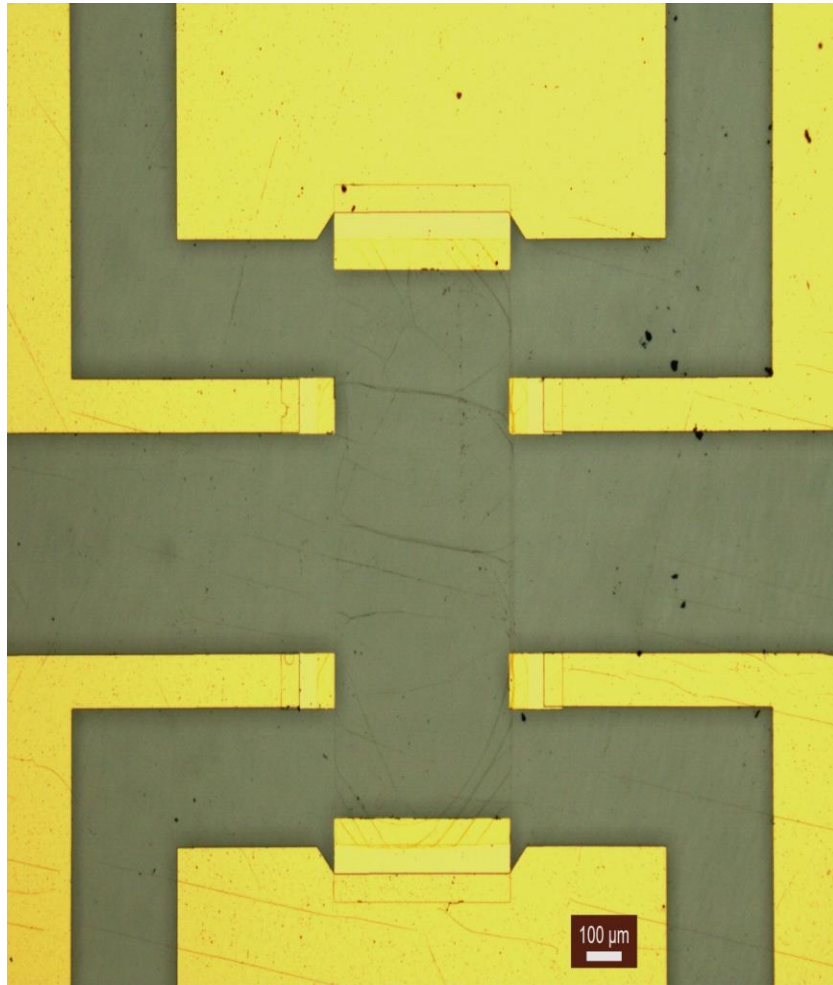
X573a Low Temperature



X575a Low Temperature

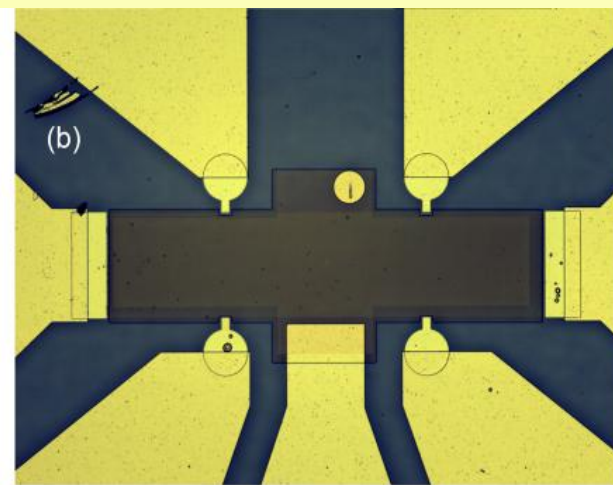
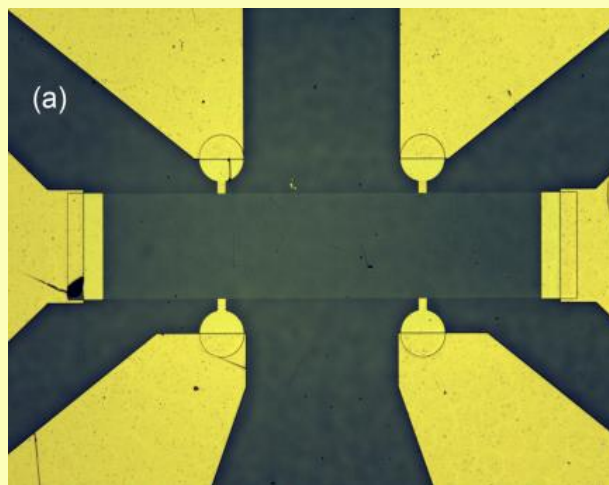
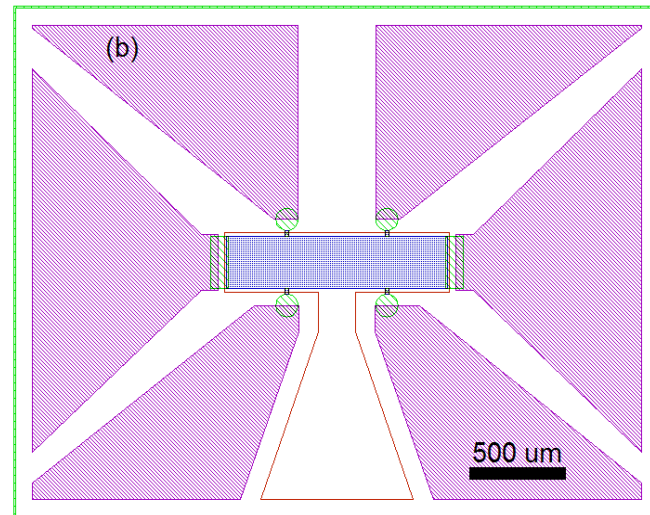
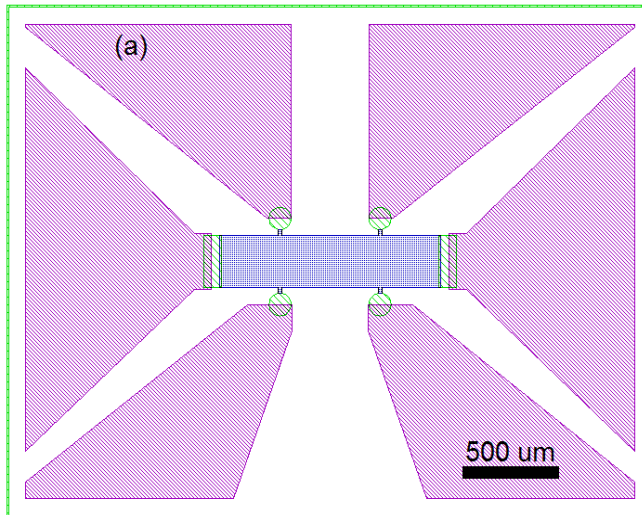


Hall Bar Fabrication for Magnetoresistance Measurements

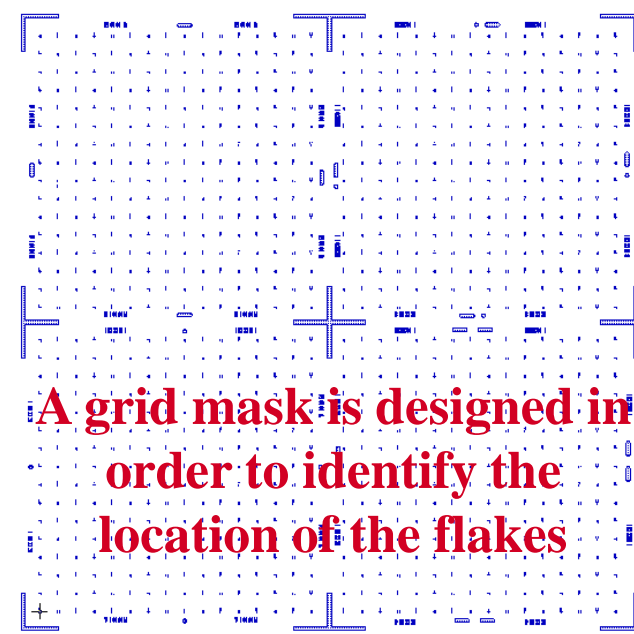
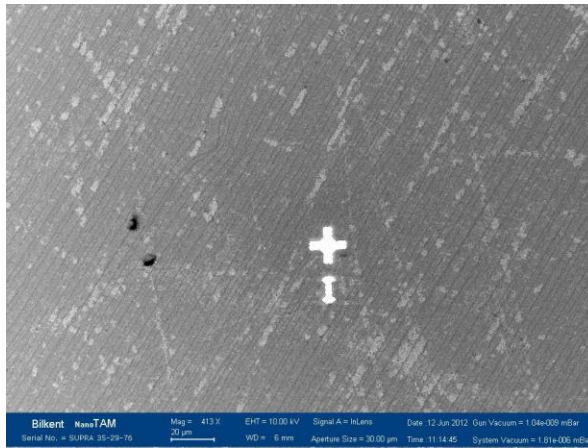


E. Tiras et al. , JAP **113**, (2013).

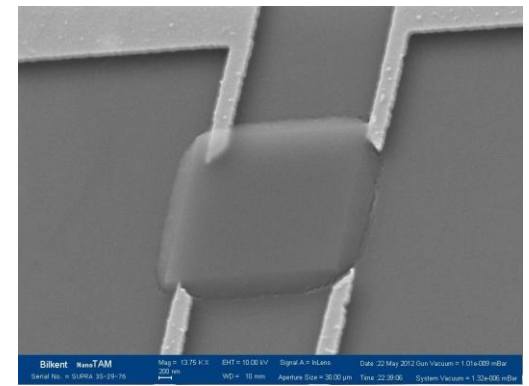
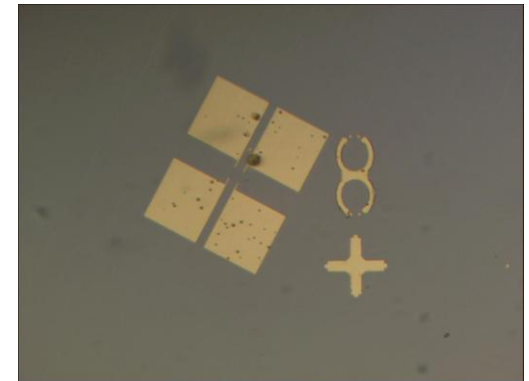
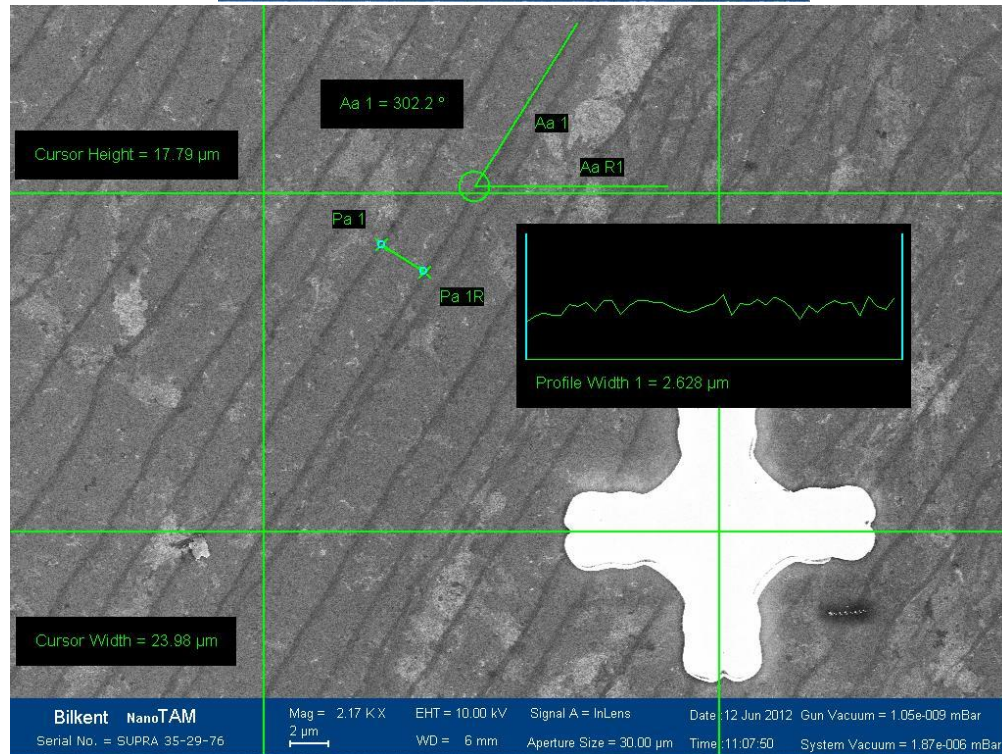
Hall Transistor Fabrication



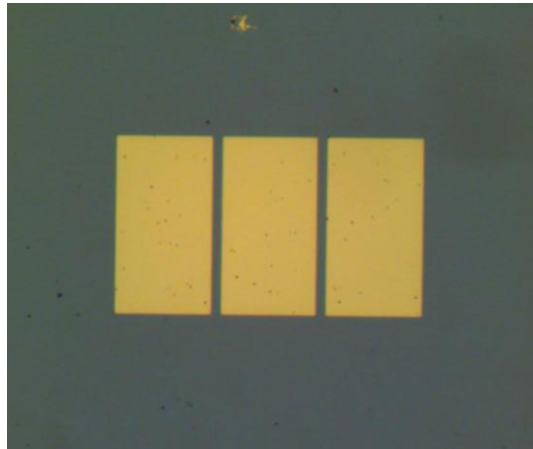
Micro Hall Bars



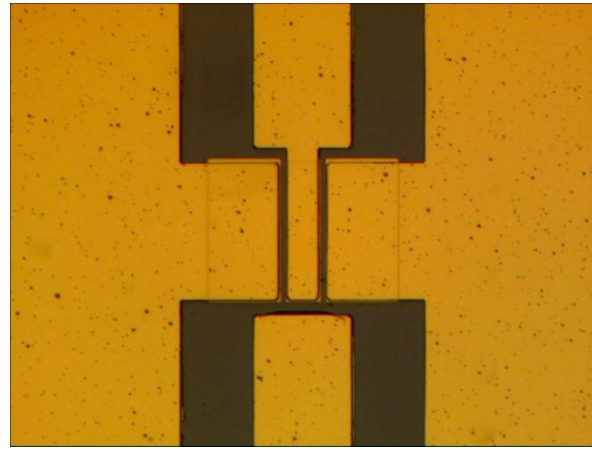
A grid mask is designed in order to identify the location of the flakes



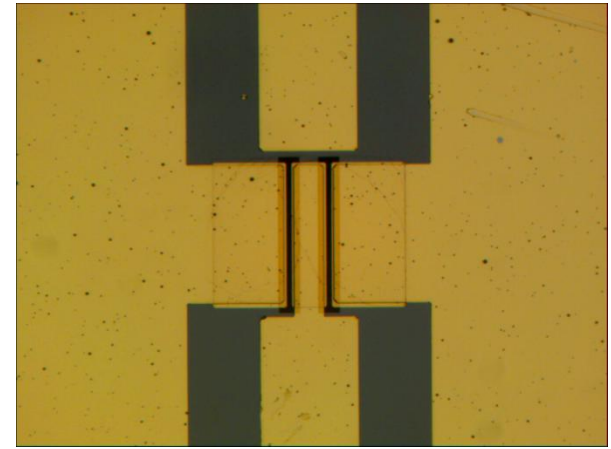
RF Transistor Fabrication Steps



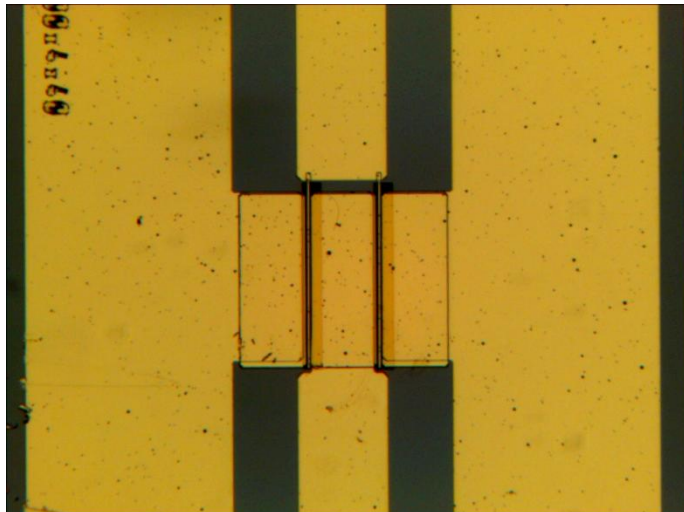
Ohmic contacts



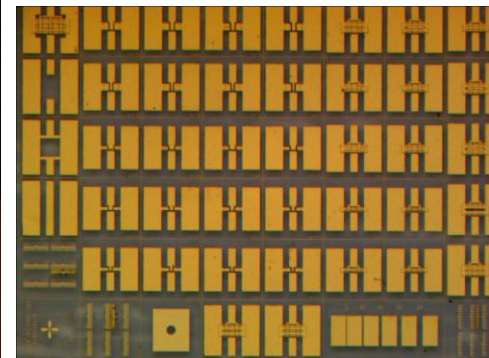
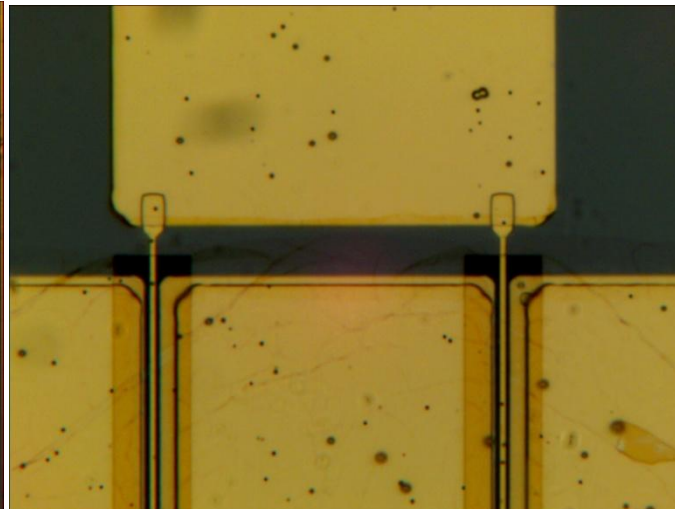
Interconnect metals



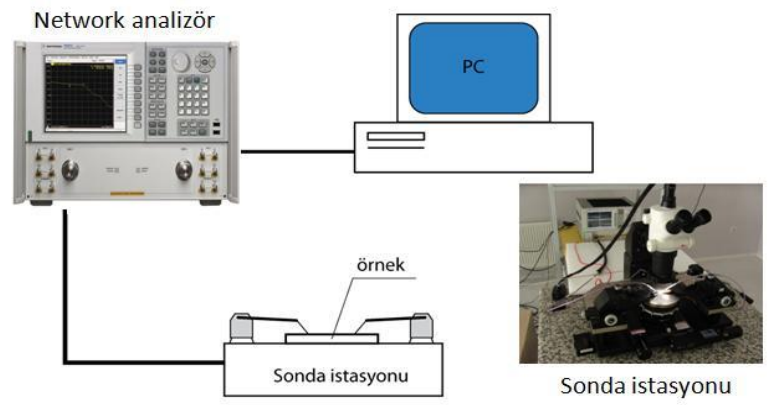
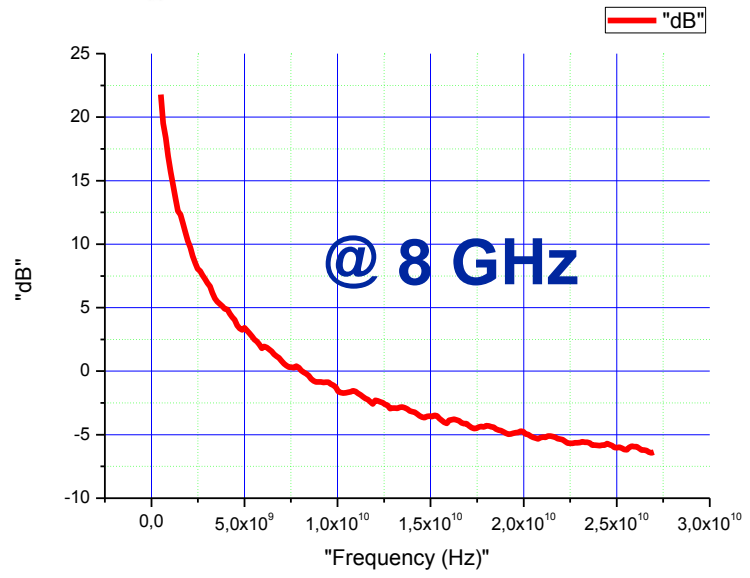
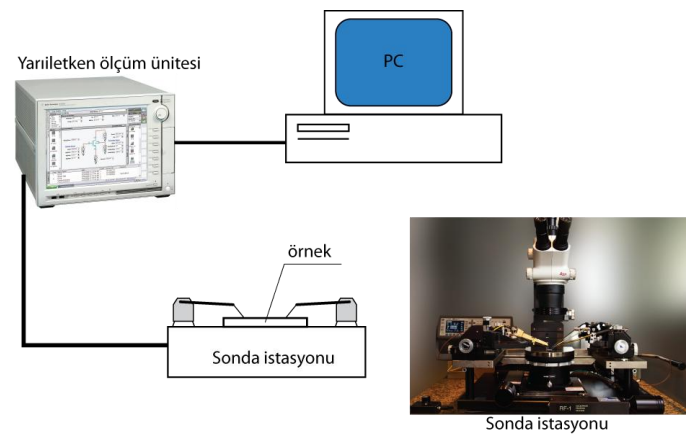
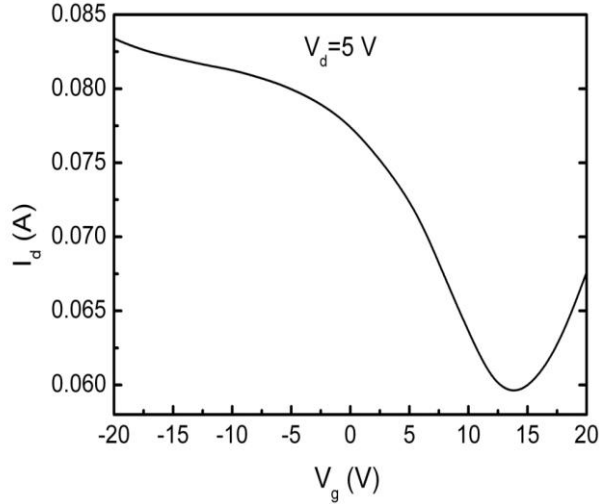
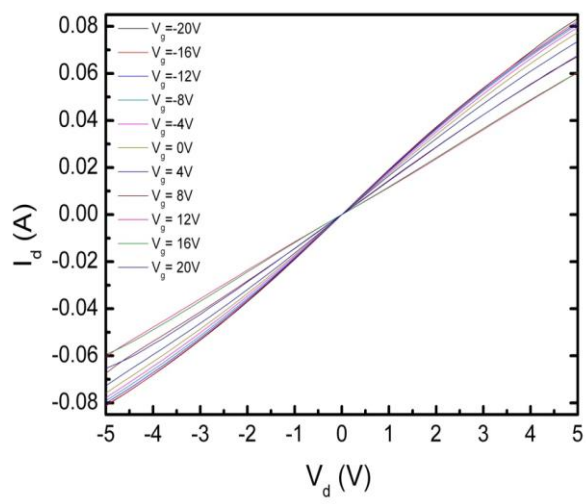
Passivation of active region with SiO_2



Gates



Transistor Measurements



$$H_{21} = \frac{-2 \cdot S_{21}}{(1 - S_{11}) \cdot (1 + S_{22}) + S_{12} \cdot S_{21}}$$

Graphene plasmonics

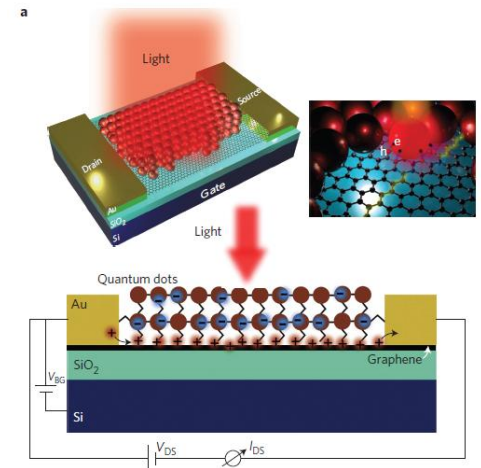
A. N. Grigorenko¹, M. Polini² and K. S. Novoselov¹

Two rich and vibrant fields of investigation—graphene physics and plasmonics—strongly overlap. Not only does graphene possess intrinsic plasmons that are tunable and adjustable, but a combination of graphene with noble-metal nanostructures promises a variety of exciting applications for conventional plasmonics. The versatility of graphene means that graphene-based plasmonics may enable the manufacture of novel optical devices working in different frequency ranges—from terahertz to the visible—with extremely high speed, low driving voltage, low power consumption and compact sizes. Here we review the field emerging at the intersection of graphene physics and plasmonics.

nature nanotechnology LETTERS
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Hybrid graphene-quantum dot phototransistors with ultrahigh gain

Gerasimos Konstantatos^{†*}, Michela Badioli, Louis Gaudreau, Johann Osmond, Maria Bernechea, F. Pelayo Garcia de Arquer, Fabio Gatti and Frank H. L. Koppens^{†*}

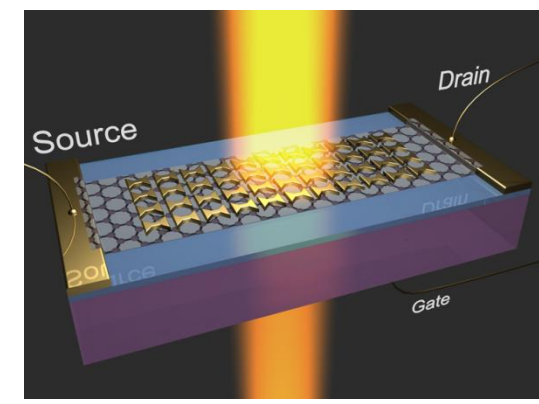


NANO LETTERS

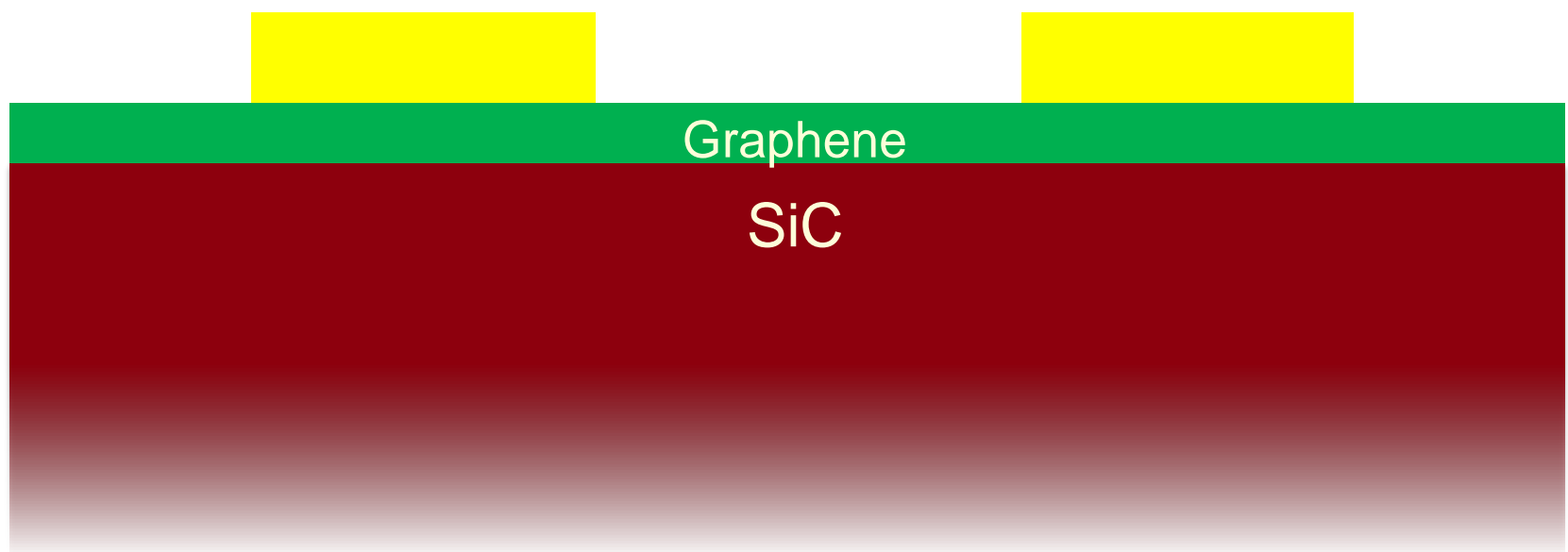
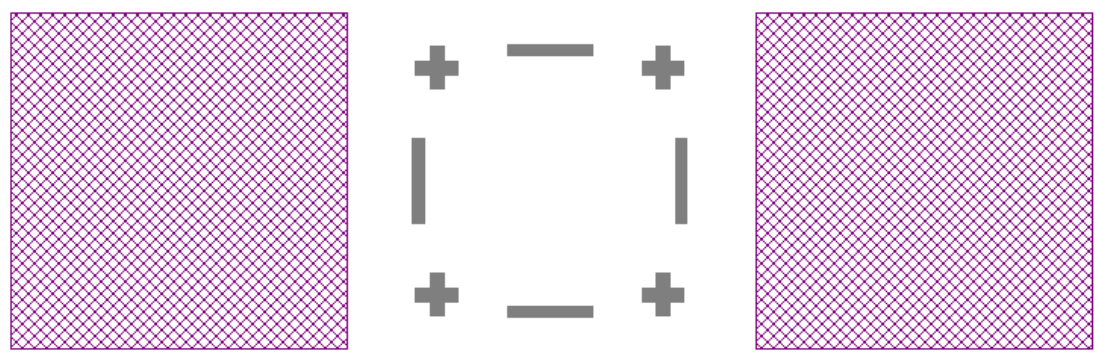
Letter
pubs.acs.org/NanoLett

Electrically Tunable Damping of Plasmonic Resonances with Graphene

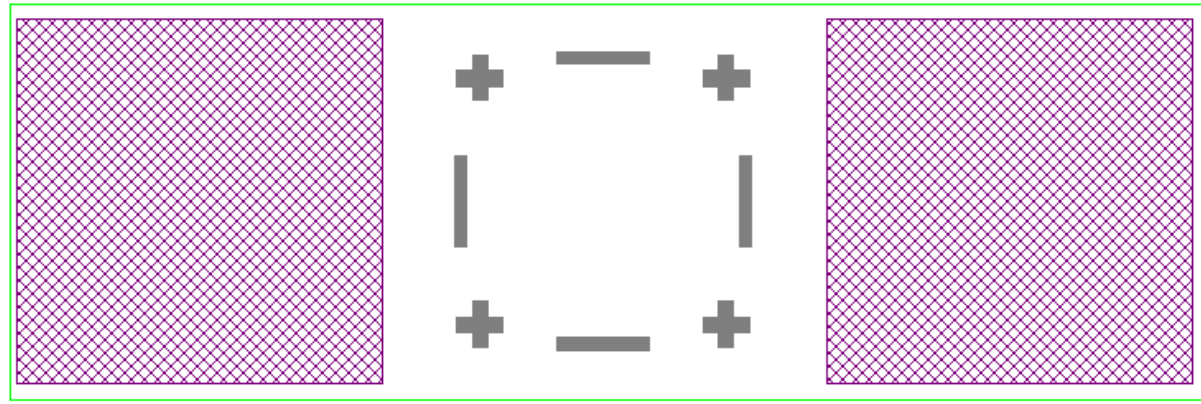
Naresh K. Emani,^{†,§} Ting-Fung Chung,^{‡,§} Xingjie Ni,^{†,§} Alexander V. Kildishev,^{†,§} Yong P. Chen,^{‡,†,§} and Alexandra Boltasseva^{*,†,§,||}



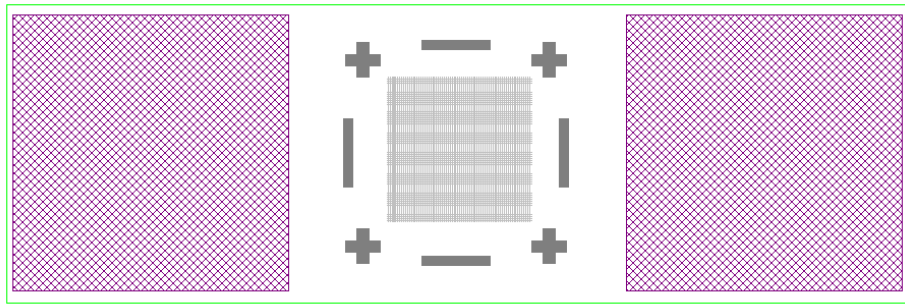
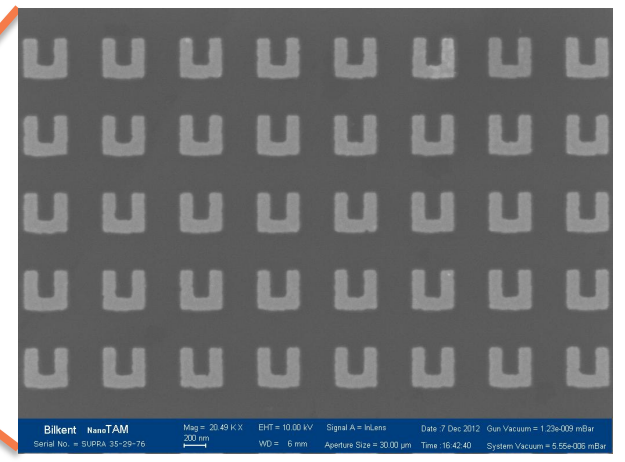
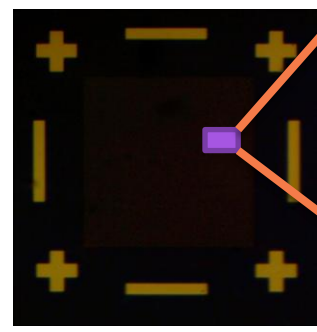
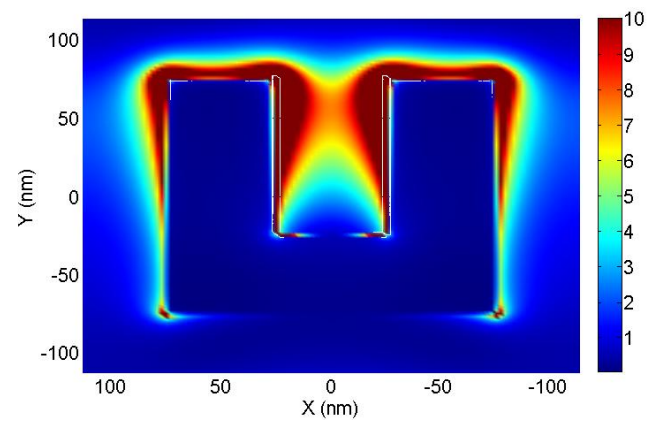
Ohmic Contacts and Alignment Marks



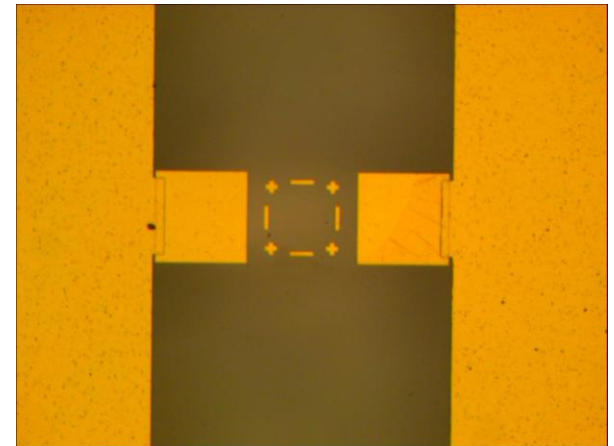
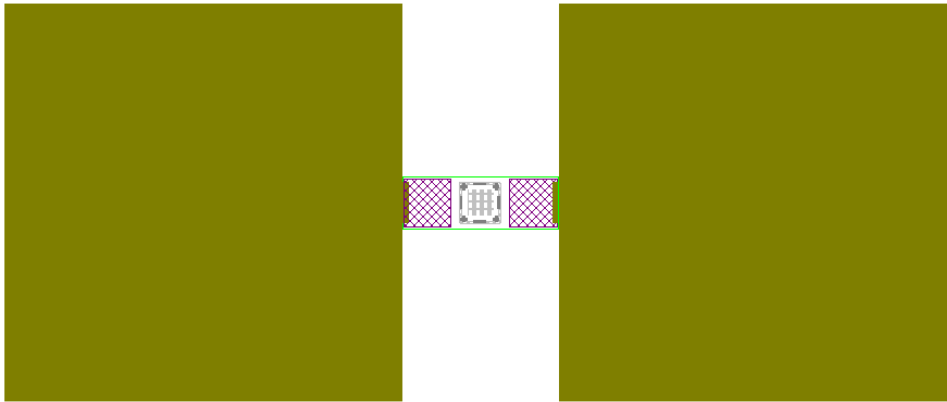
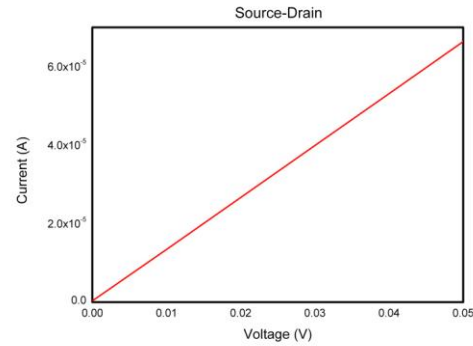
Mesa Etching of the Active Region



SRR Fabrication



Interconnect Metallization

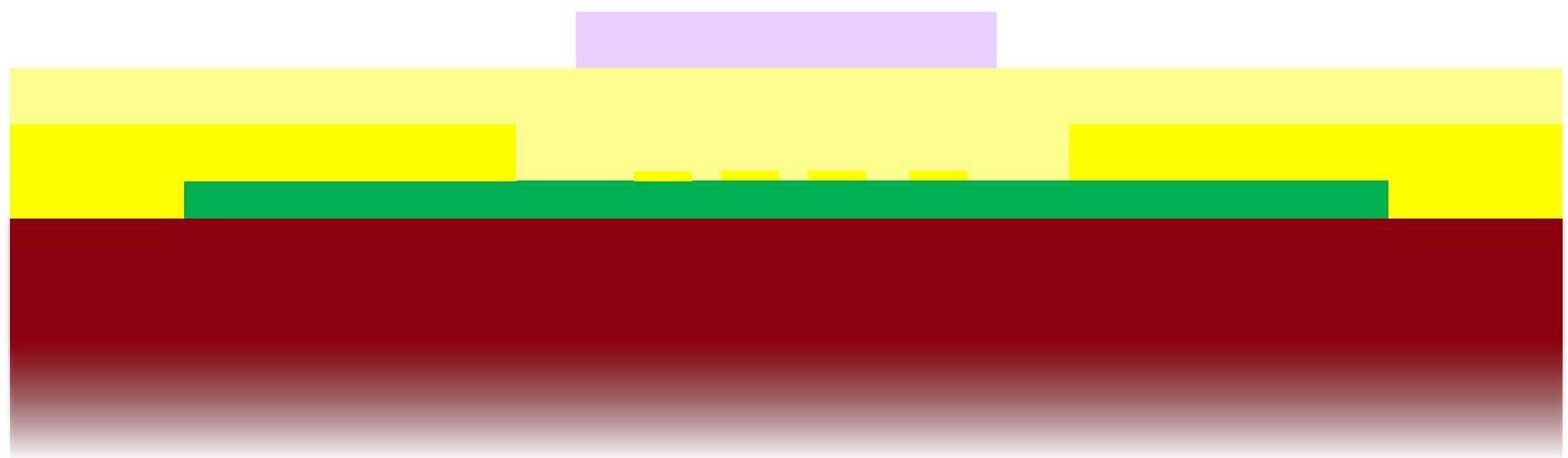
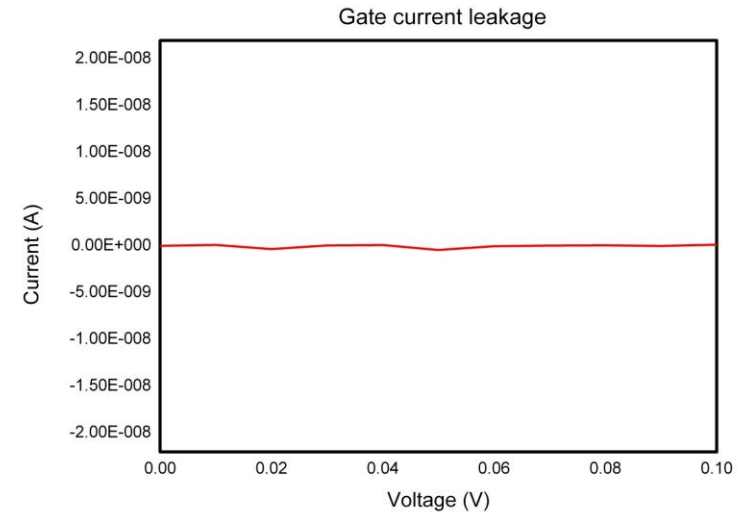
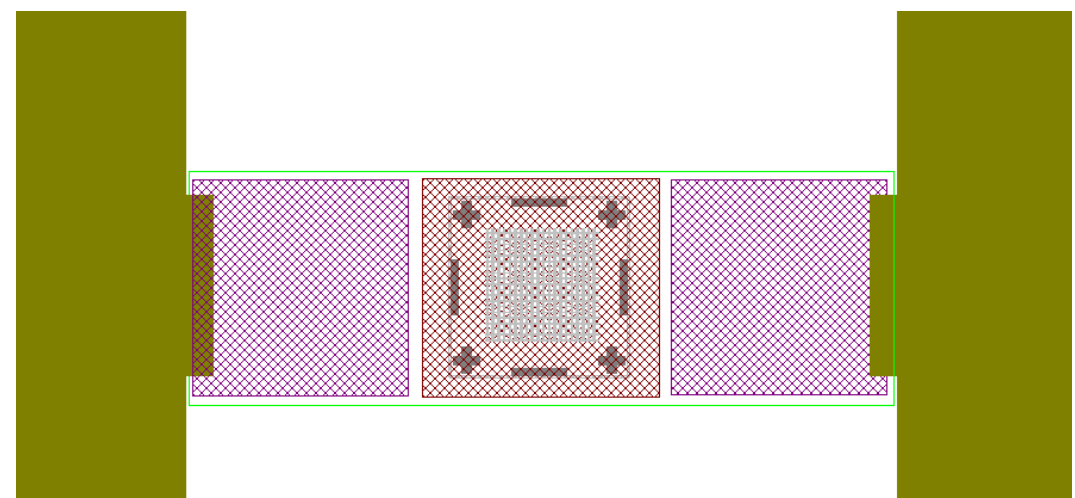


Dielectric Passivation

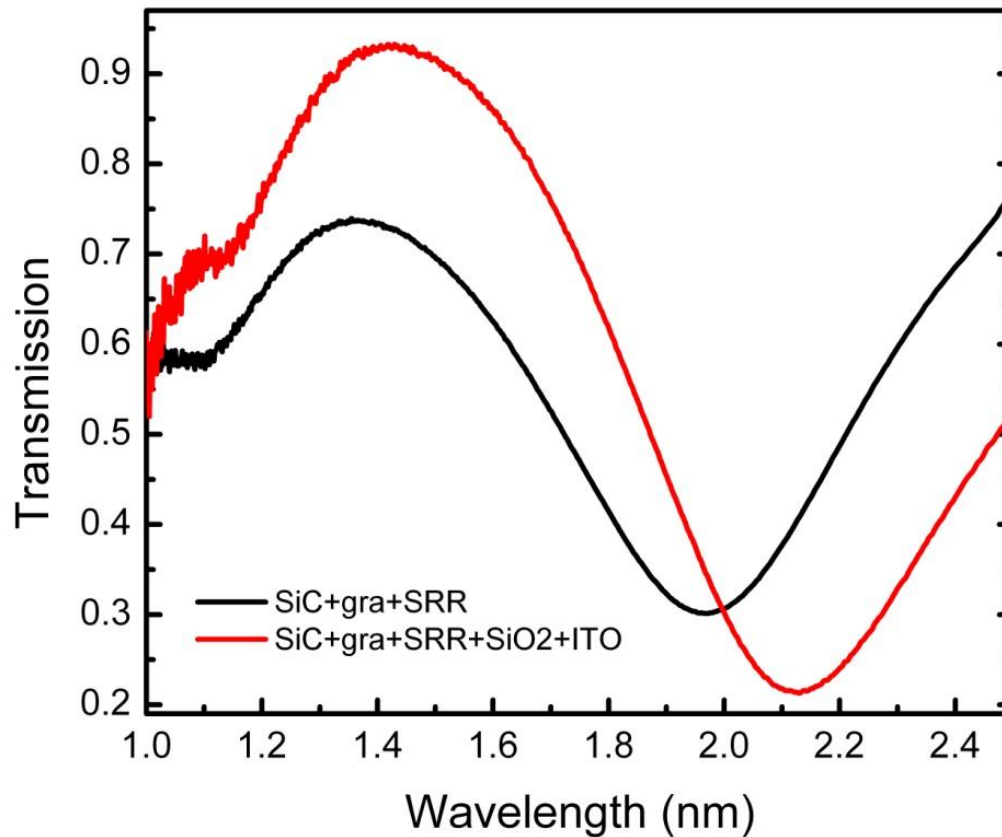
- 50 nm SiO₂ deposition with electron beam evaporation
- 50 nm SiO₂ deposition with sputter



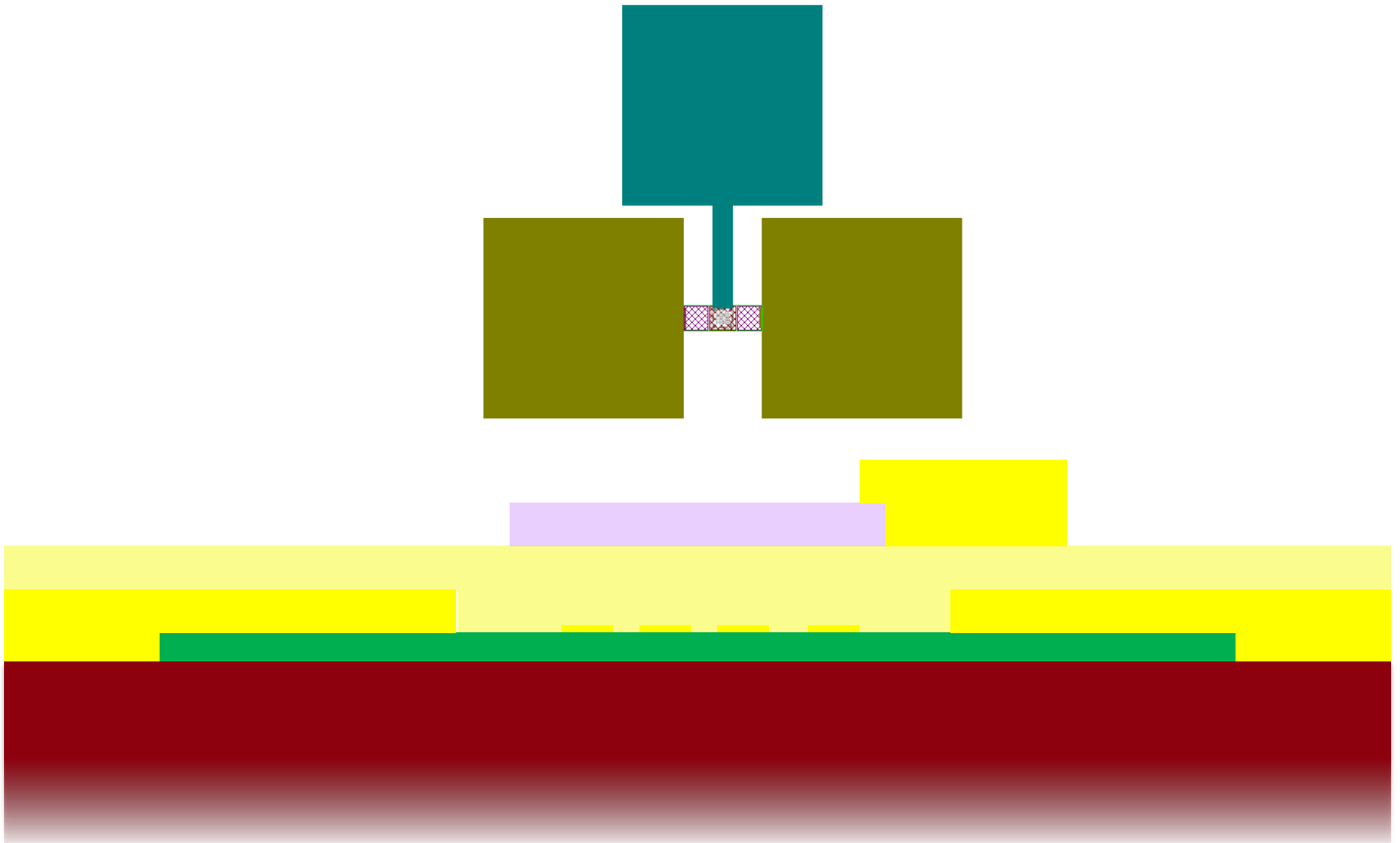
ITO Deposition as a Gate



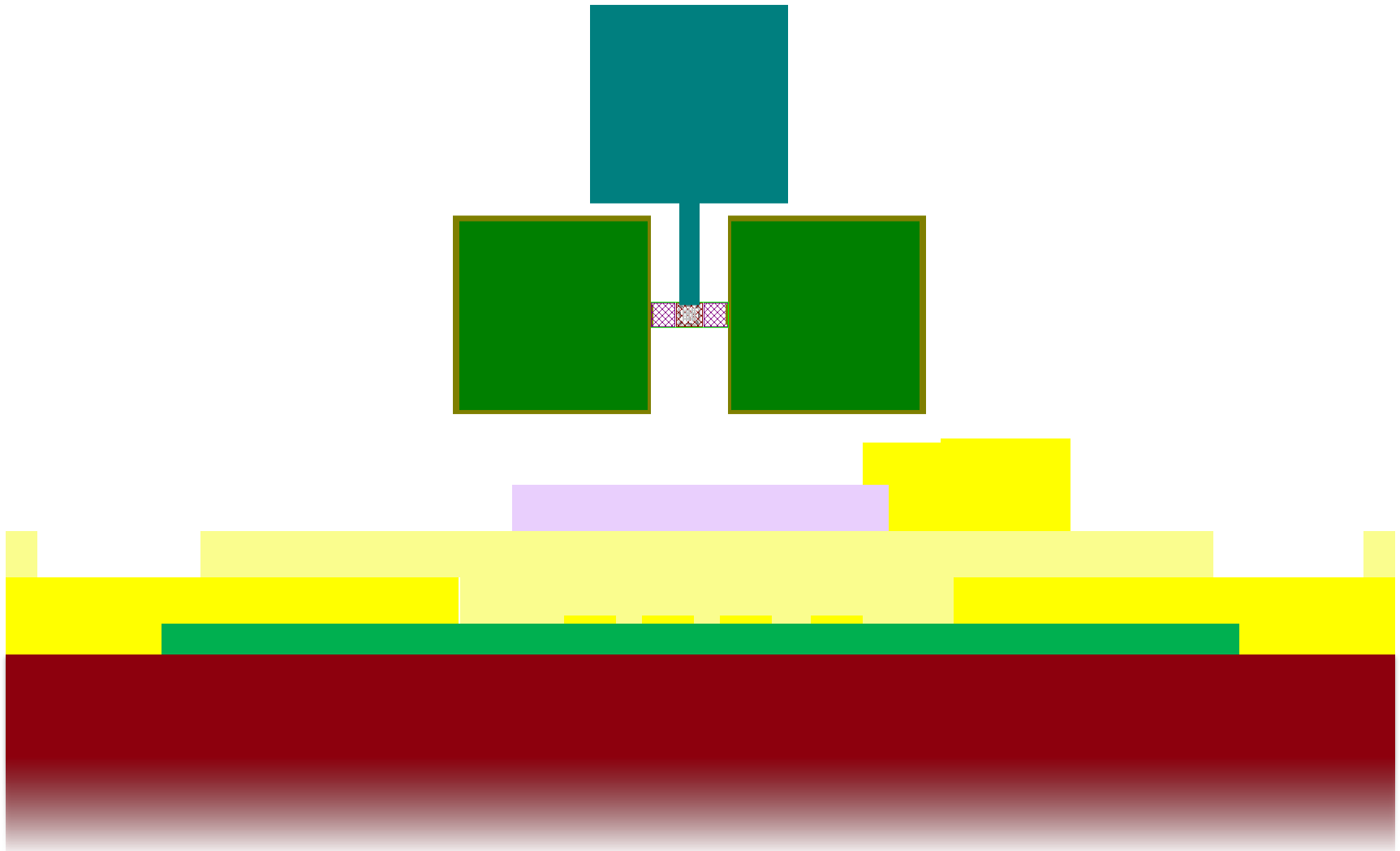
Effect of SiO₂ and ITO on the transmission



Gate Interconnect

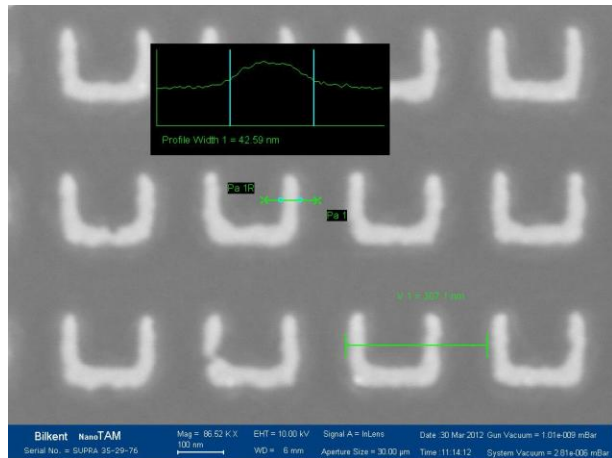


SiO₂ etching to reach the contacts

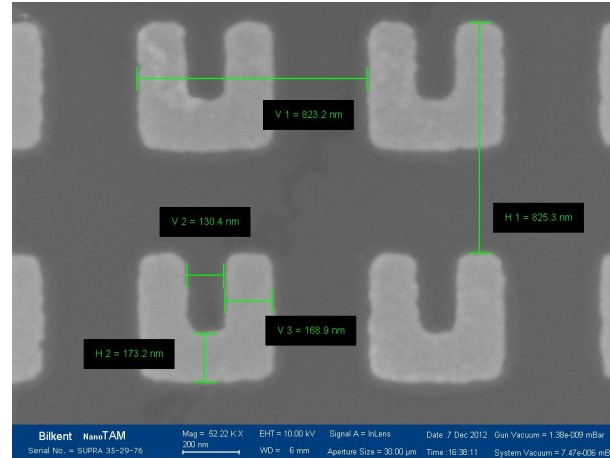


SRR Structures with Different Dimensions

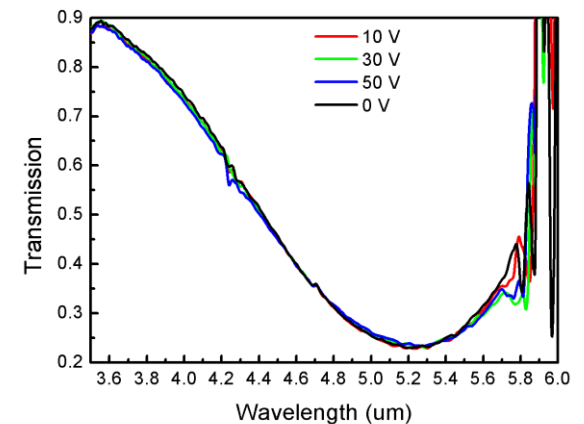
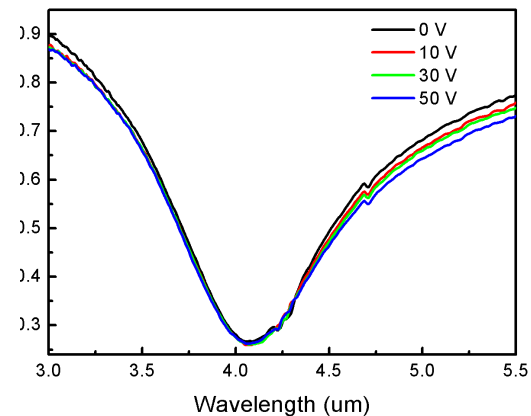
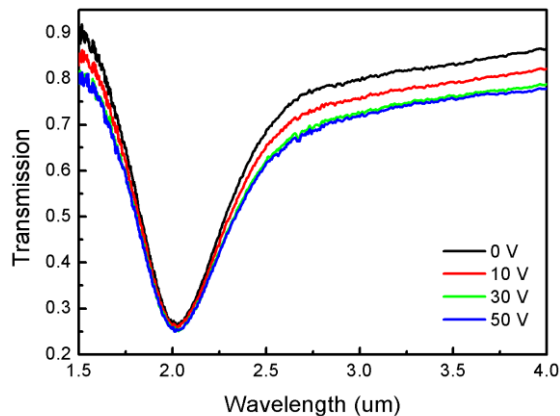
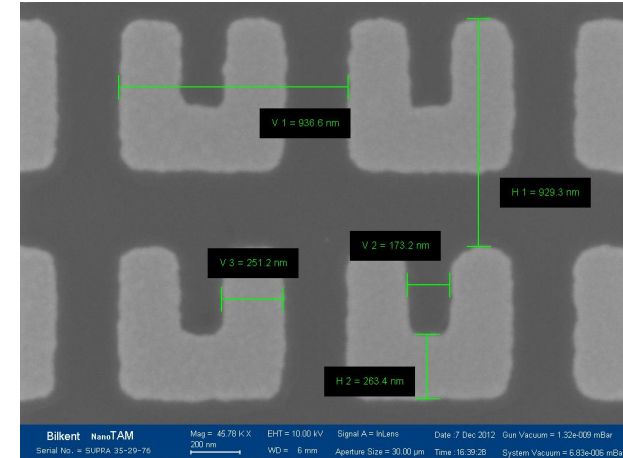
Device 1



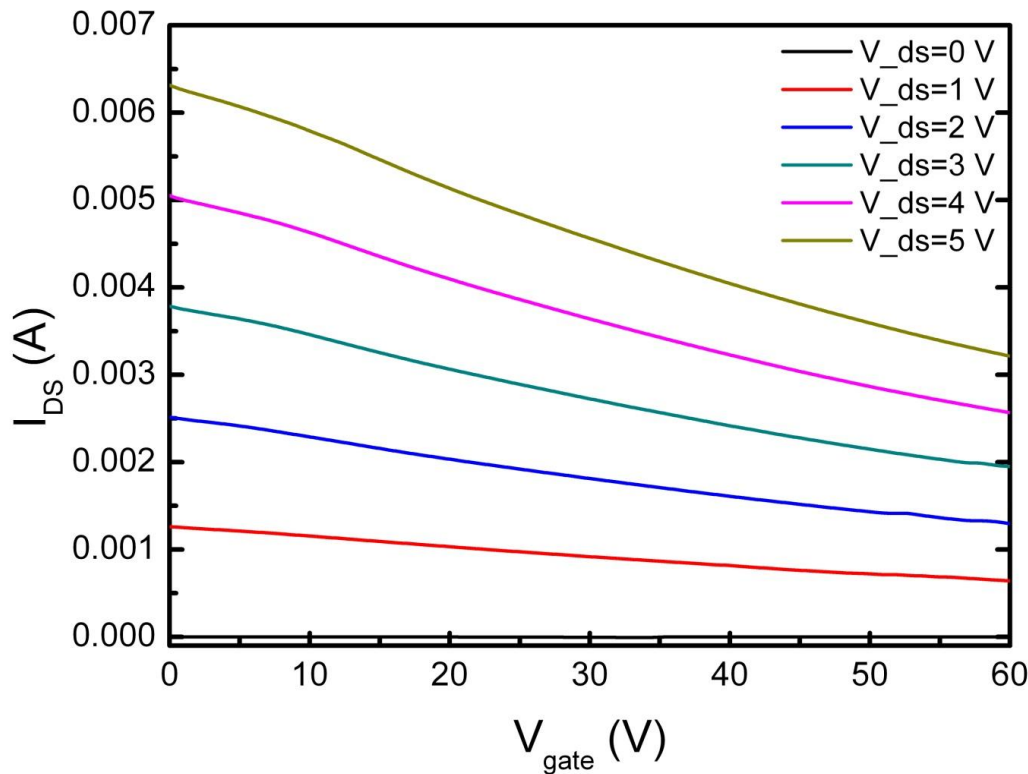
Device 2



Device 3

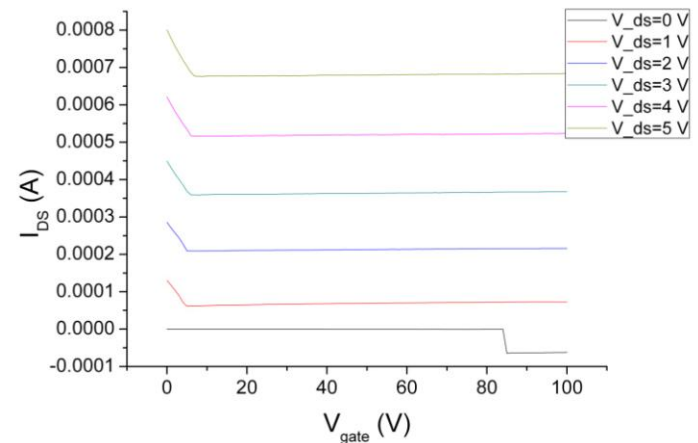


DC-IV Measurements of Plain Graphene

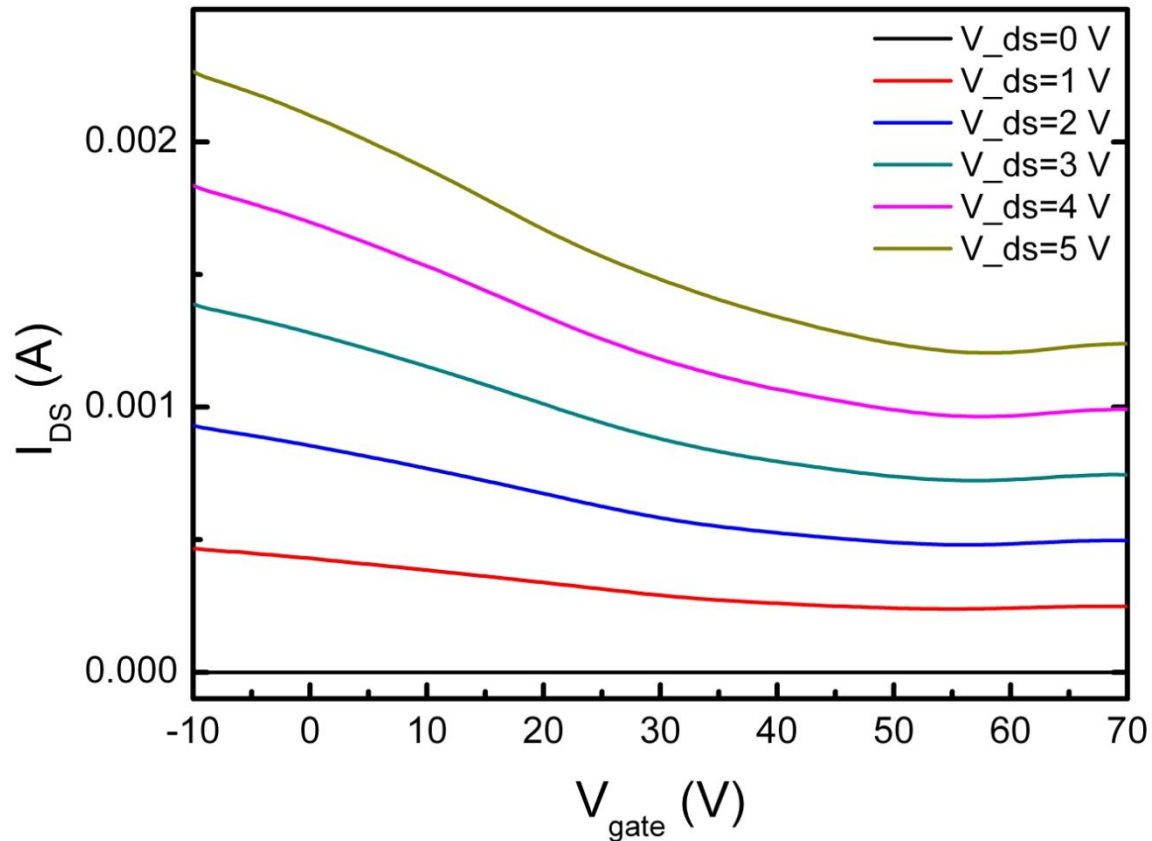


Dirac Point is larger than 60 V.

-Oxide layer breaks down instantaneously at 0.08-0.11 V per Angstrom thickness.
- This corresponds to 80-110 V for 100 nm SiO_2 .

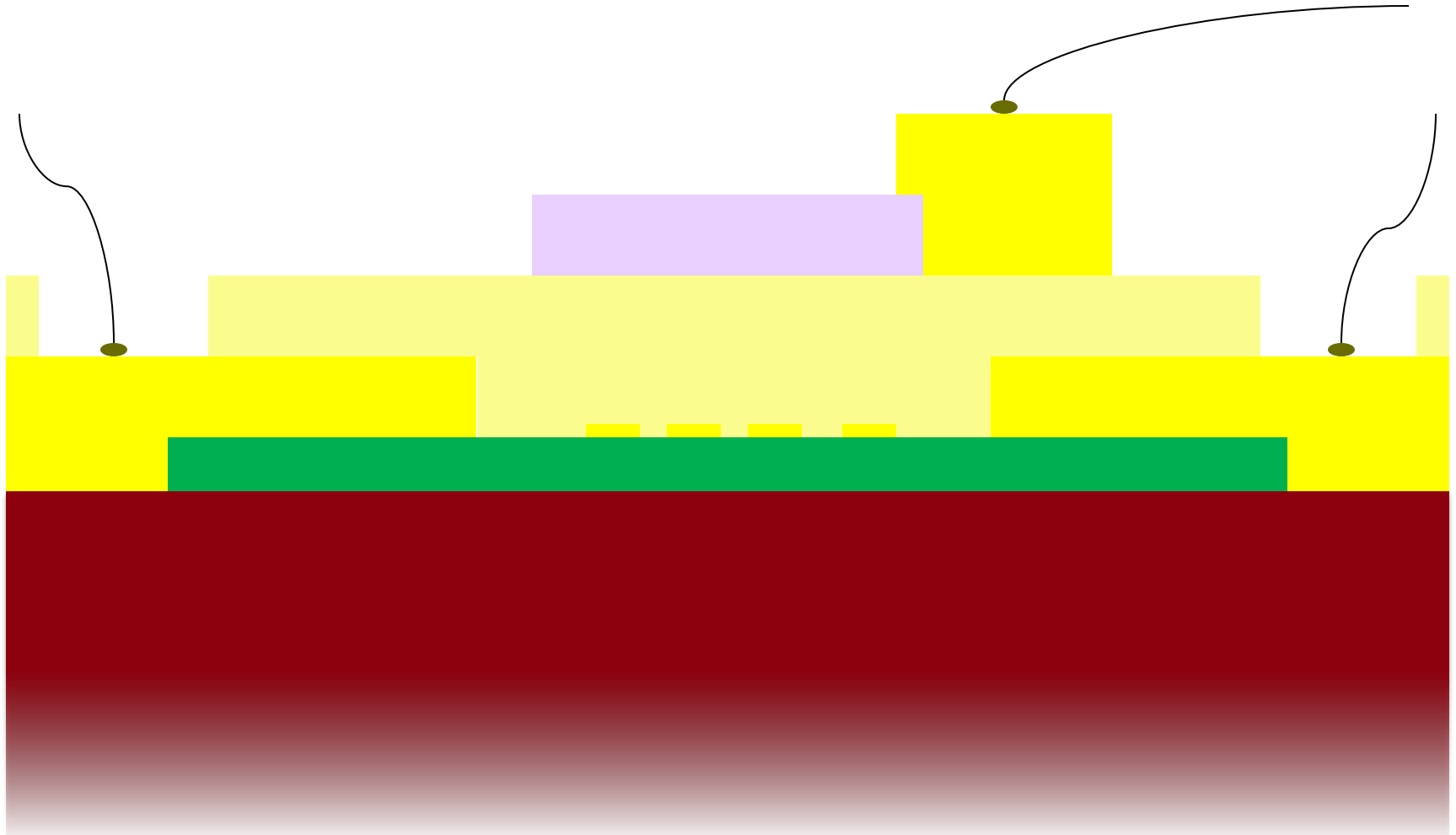


DC-IV Measurements of a Device with SRRs

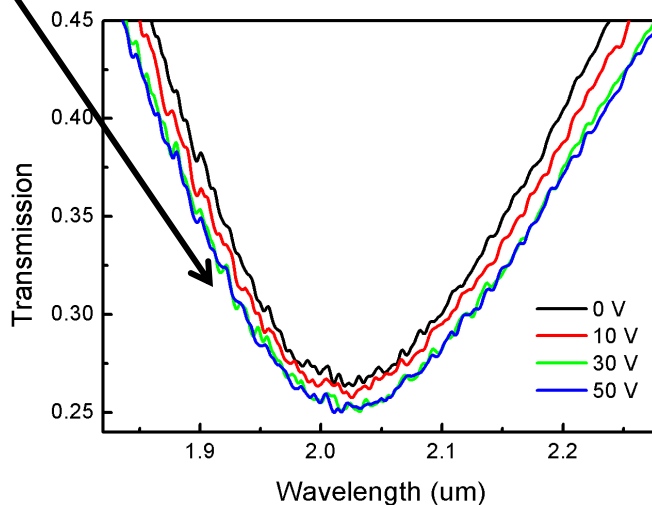
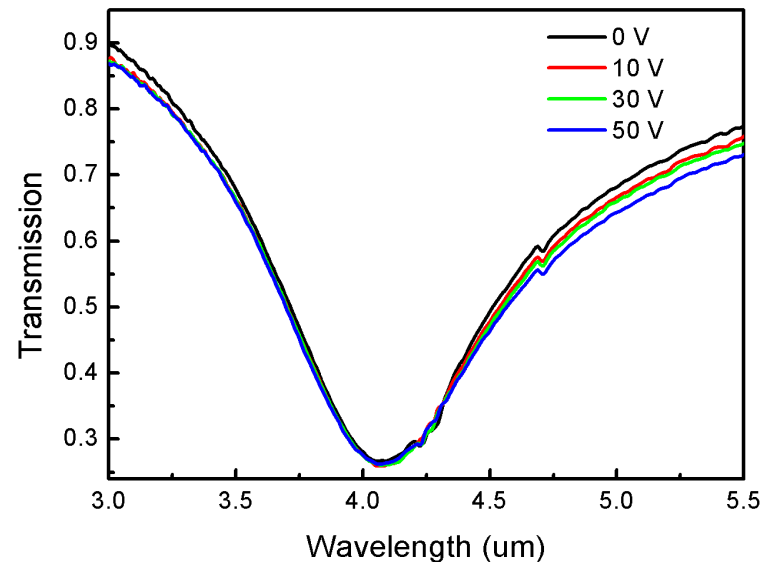
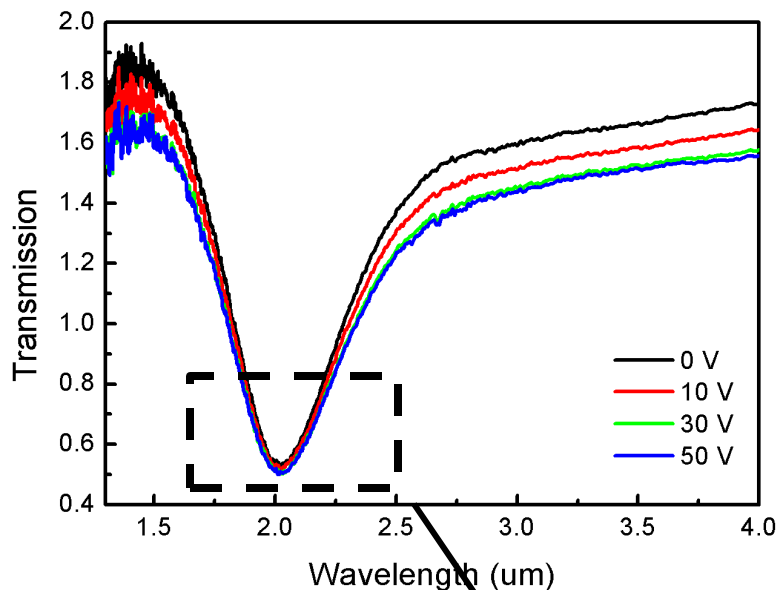


Dirac point is at 60 V.

Bonding for the Transmission Measurements



Transmission Measurement Under Different Gate Bias



-Transmission decreases with applied gate voltage.
 -The curve broadens asymmetrically.

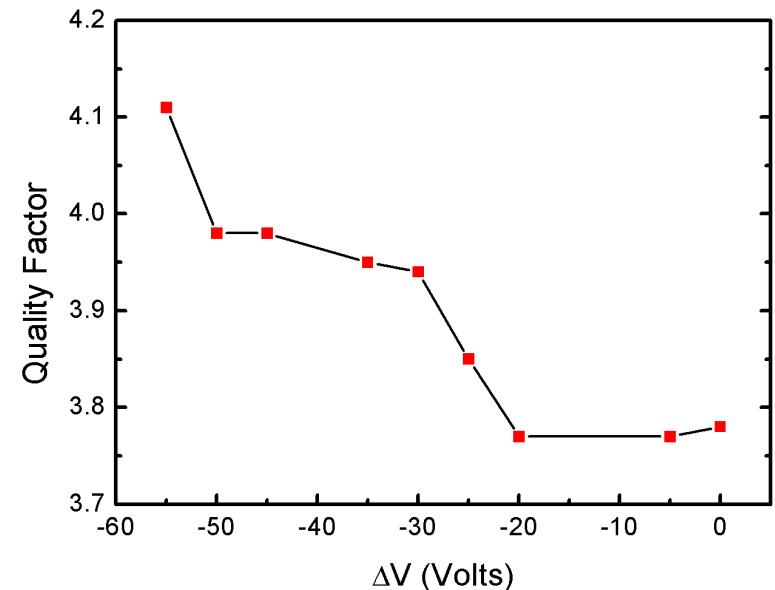
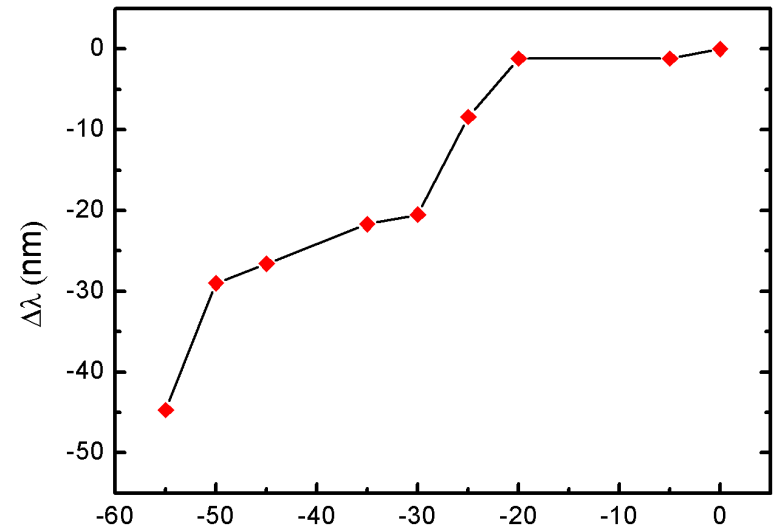
Device 1

ΔV (V)	$\Delta\lambda$ (nm)	Quality factor
0	0	3.78
-5	-1.2	3.77
-20	-1.2	3.77
-25	-8.4	3.85
-30	-20.5	3.94
-35	-21.7	3.95
-45	-26.6	3.98
-50	-29.0	3.98
-55	-44.7	4.11

$$\Delta V = V_{\text{gate}} - V_{\text{Dirac}}$$

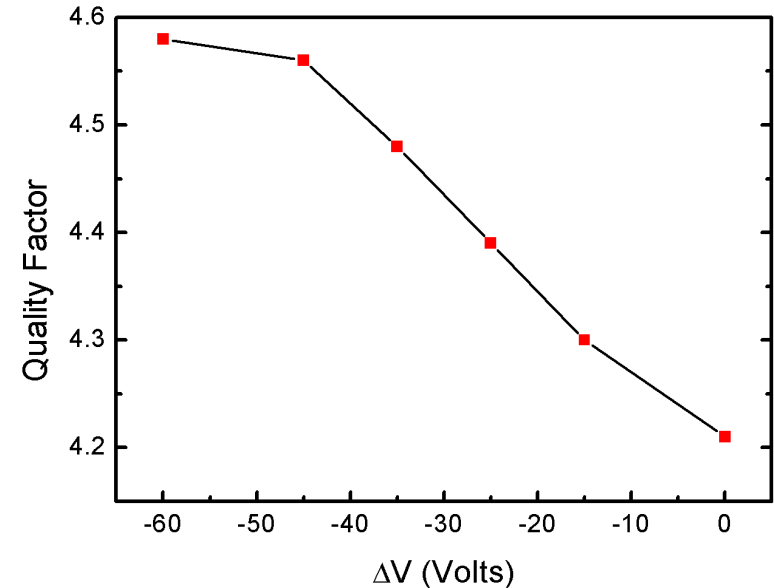
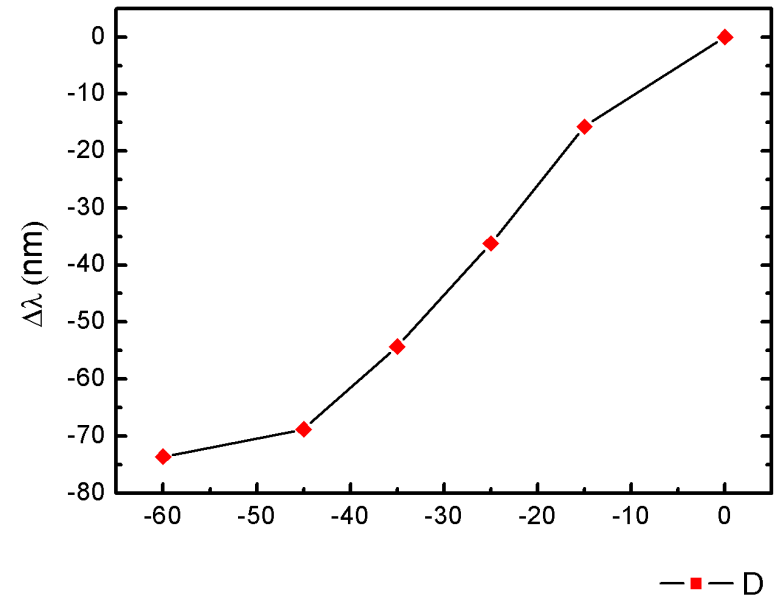
$\Delta\lambda$ is the line width difference

- Resonance dip broadens and quality factor decreases closer to Dirac point



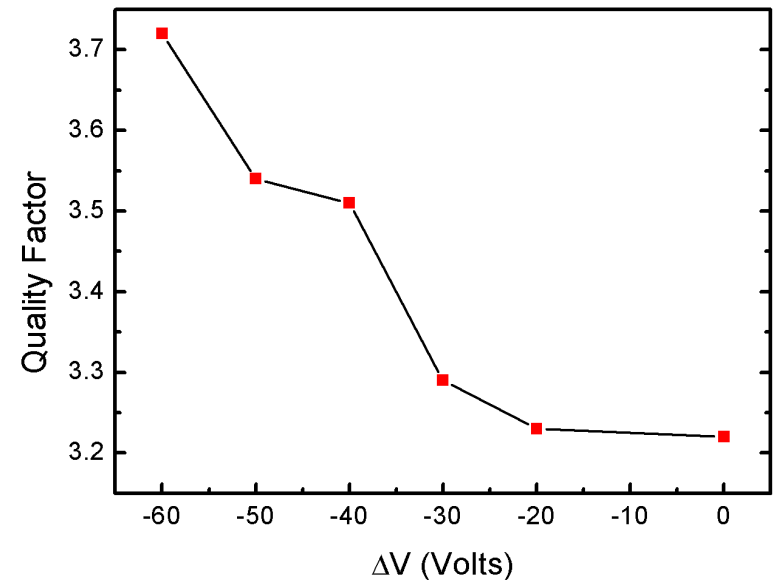
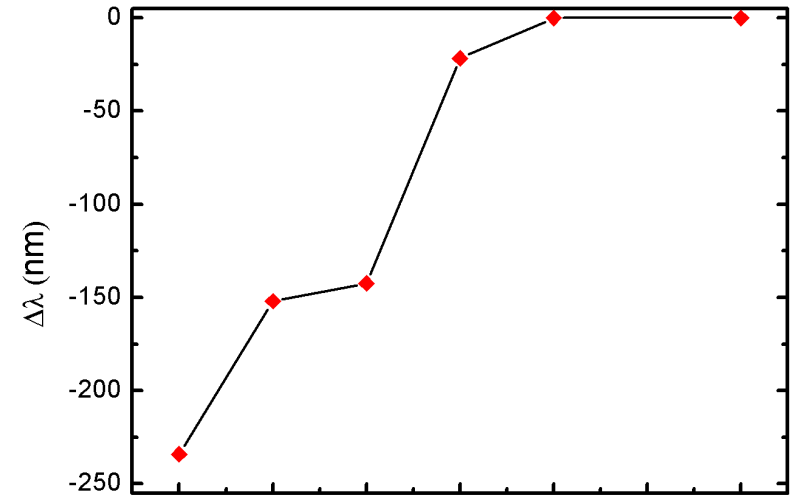
Device 2

ΔV (V)	$\Delta\lambda$ (nm)	Quality Factor
0	0	4.21
-15	-15.7	4.30
-25	-36.2	4.39
-35	-54.3	4.48
-45	-68.8	4.56
-60	-73.6	4.58

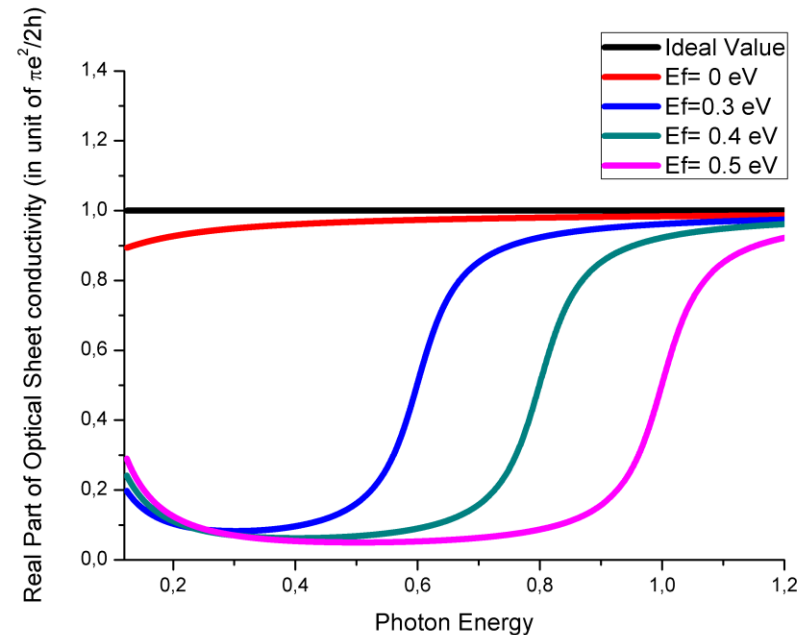
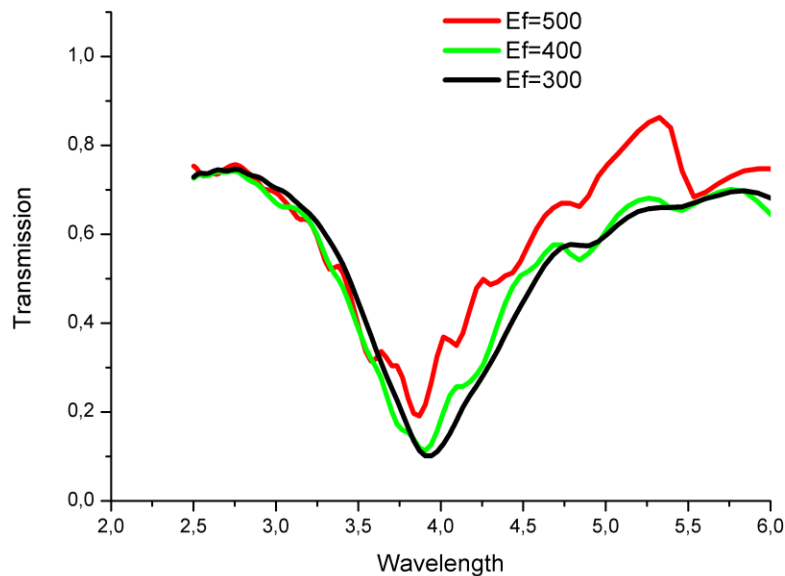


Device 3

ΔV (V)	$\Delta\lambda$ (nm)	Quality Factor
0	0	3.22
-20	0	3.23
-30	-21.7	3.29
-40	-142.4	3.51
-50	-152.0	3.54
-60	-234.1	3.72



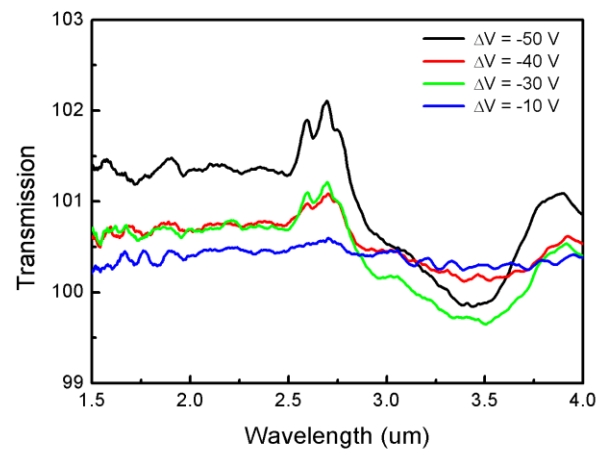
Theoretical Model for the Graphene



$$n \approx 2 \cdot 10^{13} \text{ cm}^{-2}$$

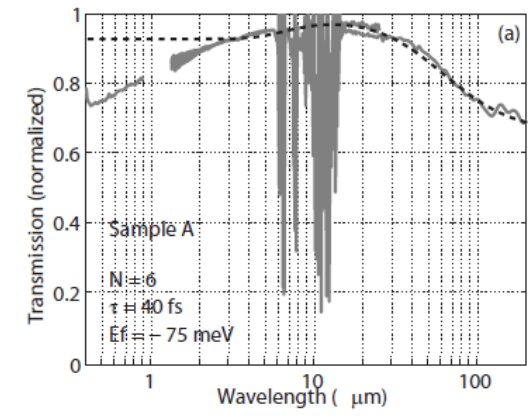
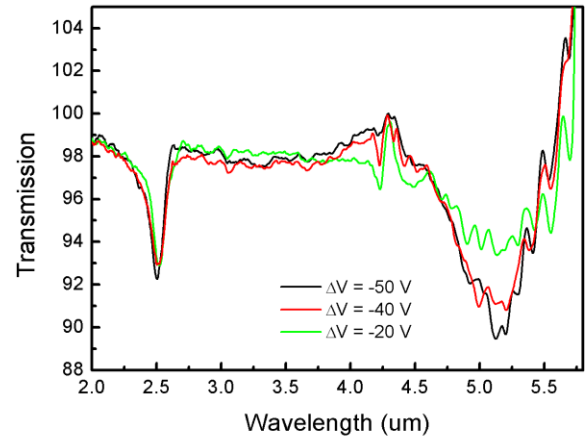
$$E_F \approx 0.5 \text{ eV}$$

Normalized Transmission with respect to Dirac Point Transmission



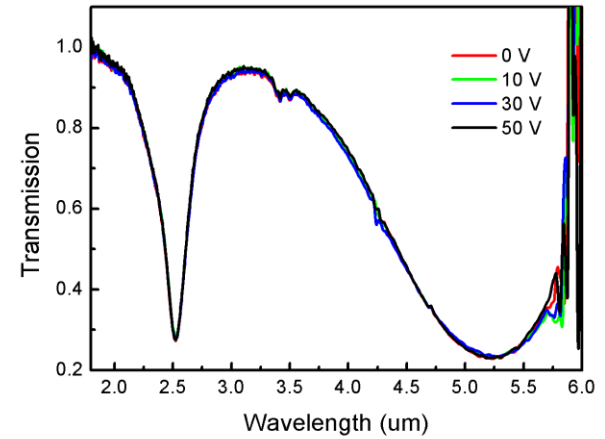
$$\left(\frac{T}{T_{\text{Dirac}}} \right) * 100$$

$$\Delta V = V_{\text{gate}} - V_{\text{Dirac}}$$

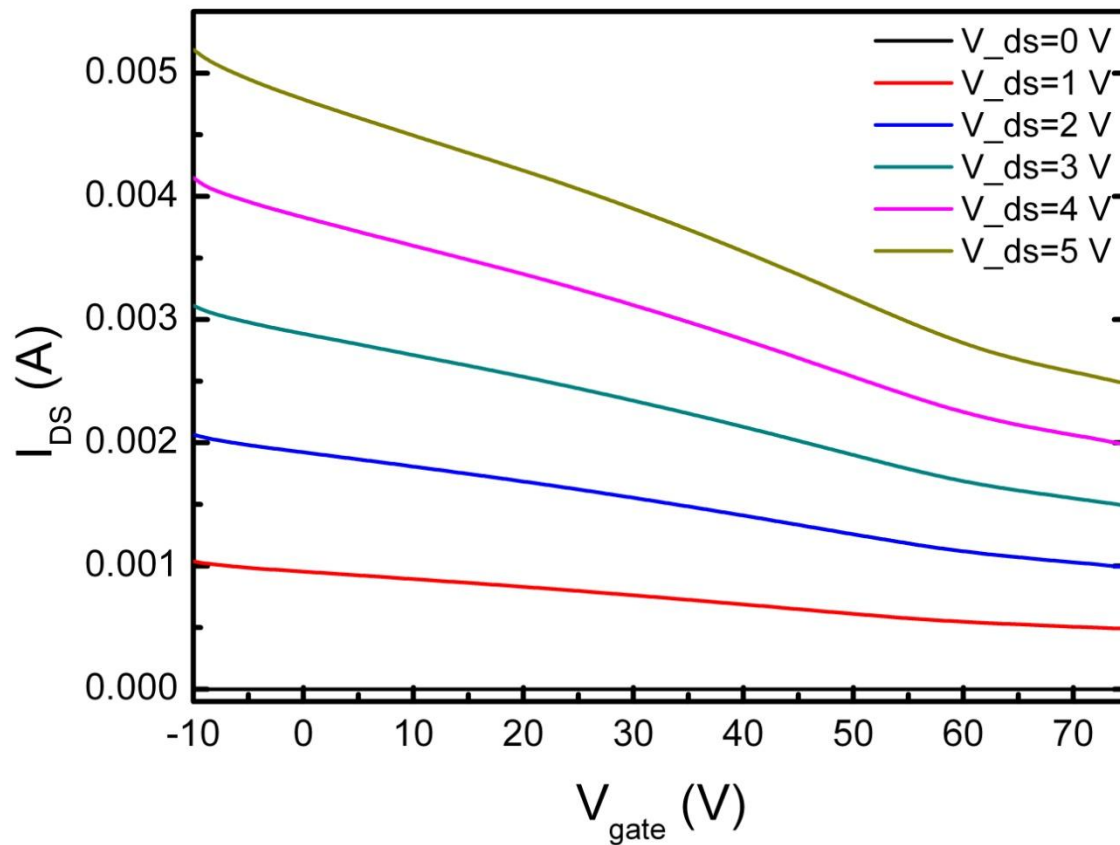


Multiphonon absorptions of SiC around 6-14 μm .

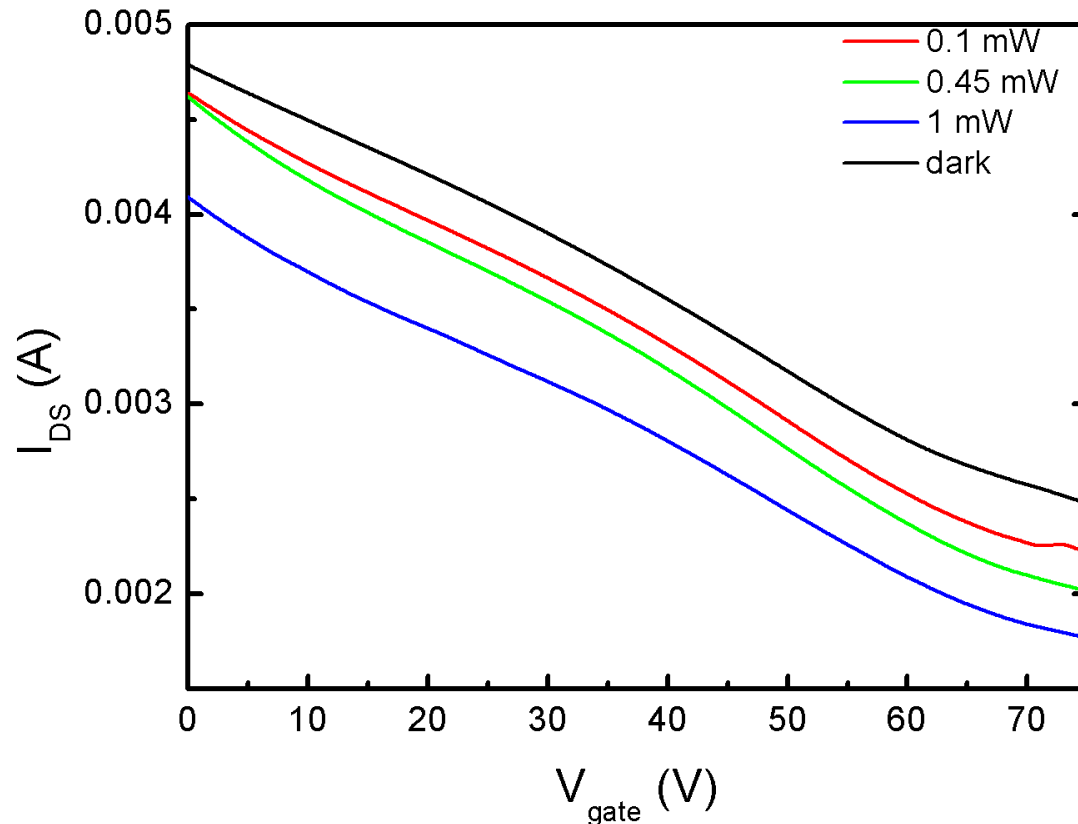
J. M. Dawlaty et al., APL **93**, (2008).



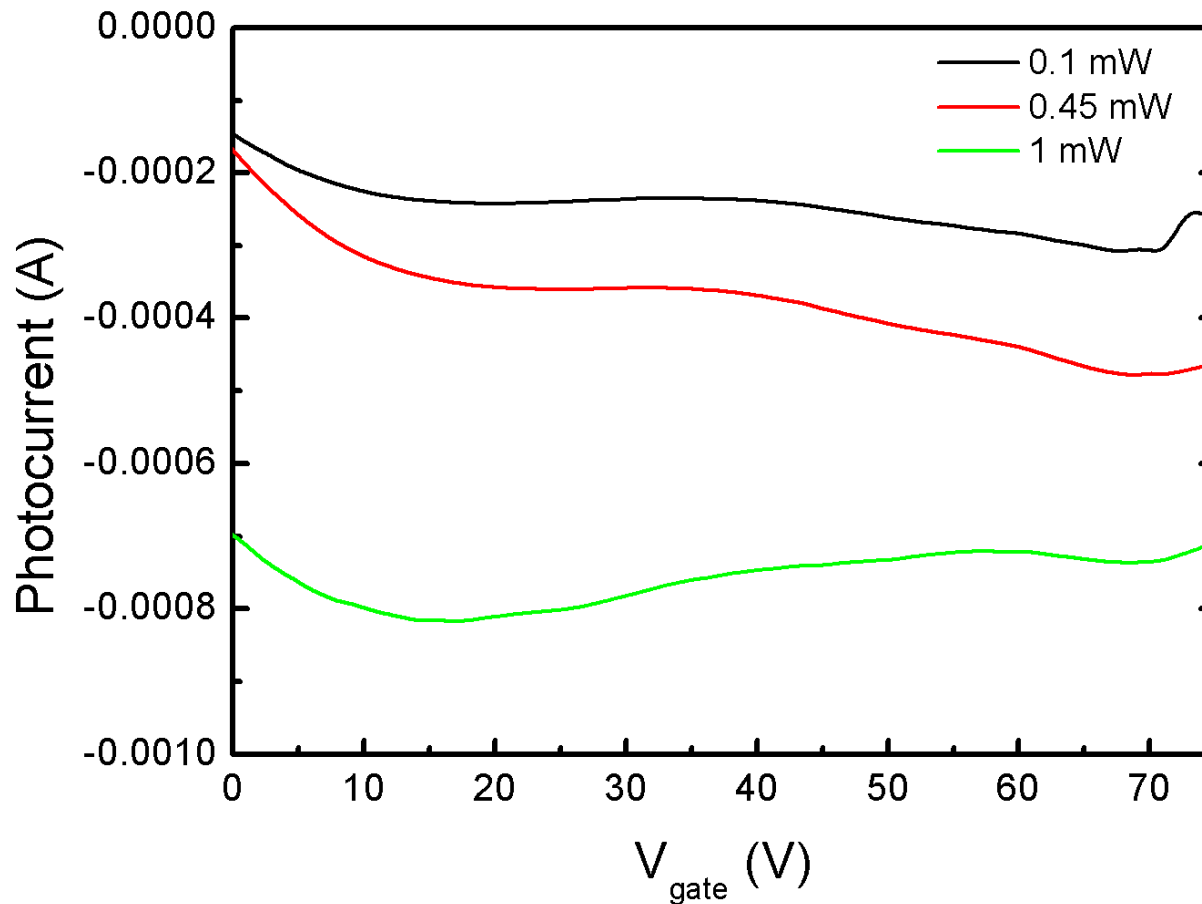
DC-IV Measurements of a Device with SRRs



DC-IV Measurements of a Device with SRRs

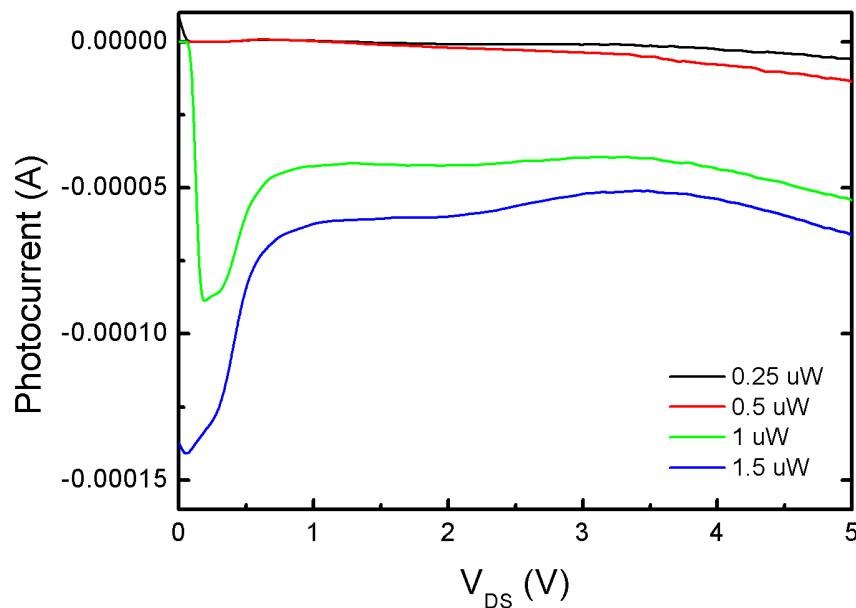


Photocurrent vs Gate Voltage

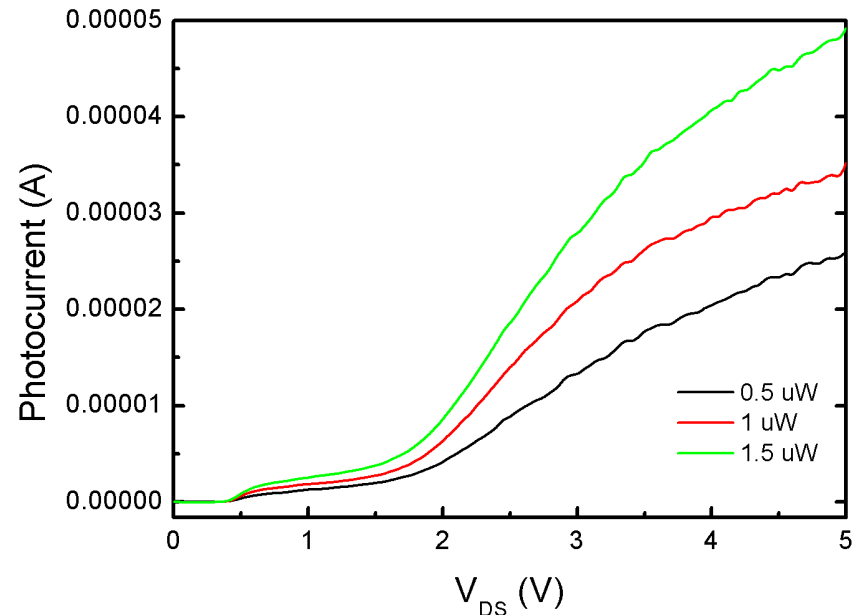


Photocurrent under different laser power at 10 V gate bias

Graphene with SRRs

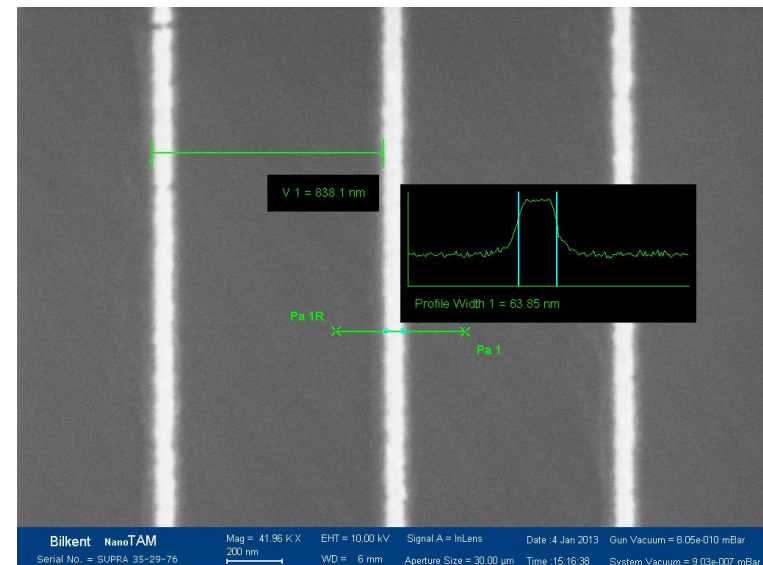
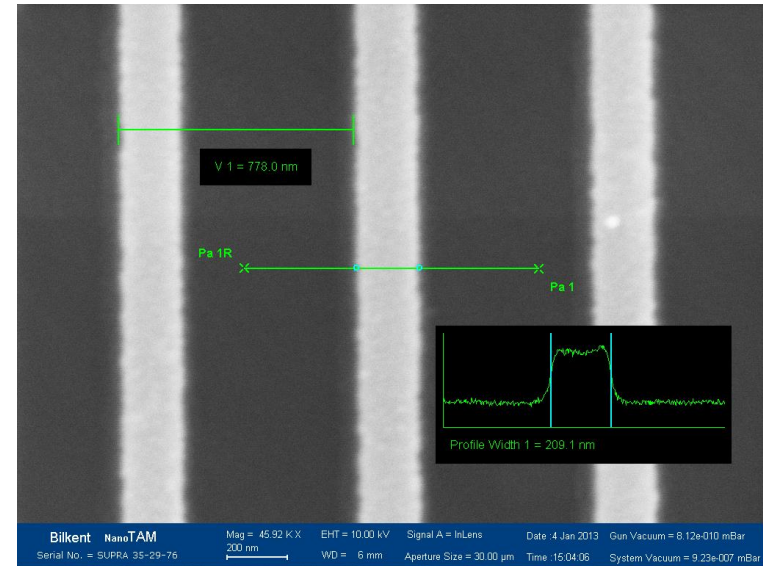
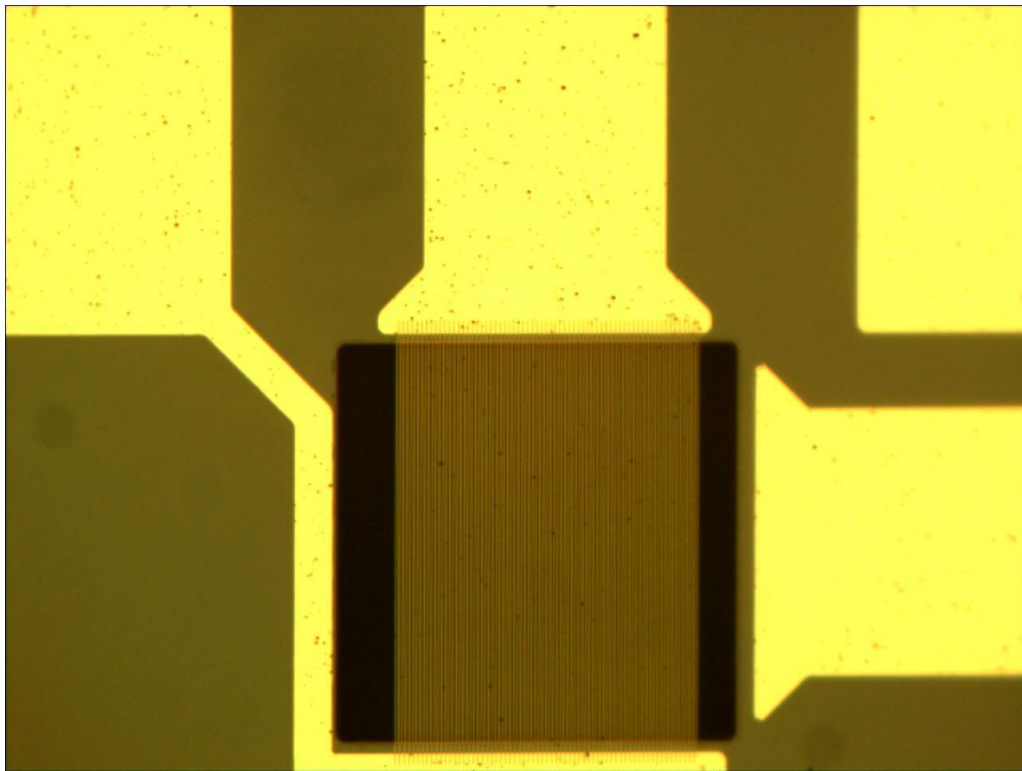


Bare Graphene



Bolometric effect: Electromagnetic wave is heating up the graphene. (?)

Future Work: Metal-Graphene-Metal Photodetector



Conclusion

- Electrical properties of graphene was investigated
- Fabrication of gated plasmonic structures realized
- Broadening and damping of transmission were observed with varying gate bias
- This effect was studied with theoretical modeling and confirmed qualitatively.

